

GD55WR512ME

GD55WR512ME

DATASHEET



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GD55WR512ME

1 FEATURES

- 512M-bit Serial Flash
 - 64M-Byte
 - 256 Bytes per programmable page
- Standard, Dual, Quad SPI
 - Standard SPI: SCLK, CS#, SI, SO, RESET#
 - Dual SPI: SCLK, CS#, IO0, IO1, RESET#
 - Quad SPI: SCLK, CS#, IO0, IO1, IO2, IO3, RESET#
 - 3 or 4-Byte Address Mode
- High Speed Clock Frequency
 - 104MHz for fast read
 - Dual I/O Data transfer up to 208Mbits/s
 - Quad I/O Data transfer up to 416Mbits/s
- Software Write Protection
 - Write protect all/portion of memory via software
 - Top/Bottom Block protection
- Endurance and Data Retention
 - Minimum 100,000 Program/Erase Cycles
 - 20-year data retention typical
- RPMC Function
 - Four 32-bit Monotonic Counters
 - Volatile HMAC Key Register
 - Non-volatile Root Key Register

- Fast Program/Erase Speed
 - Page Program time: 0.5ms typical
 - Sector Erase time: 70ms typical
 - Block Erase time: 0.25s/0.4s typical
 - Chip Erase time: 280s typical
- Flexible Architecture
 - Uniform Sector of 4K-Byte
 - Uniform Block of 32/64K-Byte
- Low Power Consumption
 - 36µA typical standby current
 - 3µA typical deep power down current
- Advanced Security Features
 - 128-bit Unique ID for each device
 - Serial Flash Discoverable parameters (SFDP) register
 - 3x2048-Byte Security Registers With OTP Locks
- Single Power Supply Voltage
 - Full voltage range: 1.65-3.6V
- Package Information
 - SOP16 300mil
 - WSON8 (8x6mm)



2 GENERAL DESCRIPTIONS

The GD55WR512ME (512M-bit) Serial flash supports the standard Serial Peripheral Interface (SPI), and the Dual/Quad SPI: Serial Clock, Chip Select, Serial Data I/O0 (SI), I/O1 (SO), I/O2, I/O3. The Dual I/O data is transferred with speed of 208Mbit/s, and the Quad I/O data is transferred with speed of 416Mbit/s.

CONNECTION DIAGRAM AND PIN DESCRIPTION

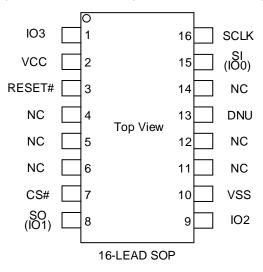


Figure 1 Connection Diagram for SOP16 package

Pin No.	Pin Name	I/O	Description
1	IO3	I/O	Data Input Output 3
2	VCC		Power Supply
3	RESET#	I	Reset Input
7	CS#	I	Chip Select Input
8	SO (IO1)	I/O	Data Output (Data Input Output 1)
9	IO2	I/O	Data Input Output 2
10	VSS		Ground
13	DNU		Do Not Use (It may connect to internal signal inside)
15	SI (IO0)	I/O	Data Input (Data Input Output 0)
16	SCLK	I	Serial Clock Input

Note:

1. CS# must be driven high if chip is not selected. Please don't leave CS# floating any time after power is on.

2. The DNU pin must be floating. It may connect to internal signal inside.

3. The NC pin is not connected to any internal signal. It is OK to connect it to the system ground (GND) or leave it floating.

4. The RESET# pin is a dedicated hardware reset pin regardless of device settings or operation states. If the hardware reset function is not used, this pin must be connected to VCC in the system.



Figure 2 Connection Diagram for WSON8 package

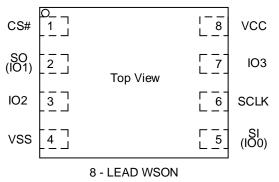


Table 2. Pin Description for WSON8 Package

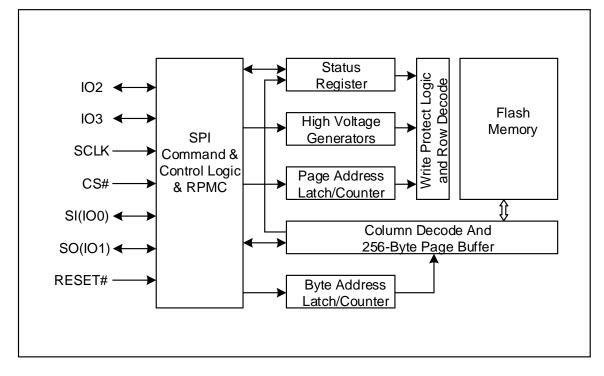
Pin No.	Pin Name	I/O	Description
1	CS#	I	Chip Select Input
2	SO (IO1)	I/O	Data Output (Data Input Output 1)
3	IO2	I/O	Data Input Output 2
4	VSS		Ground
5	SI (IO0)	I/O	Data Input (Data Input Output 0)
6	SCLK	I	Serial Clock Input
7	103	I/O	Data Input Output 3
8	VCC		Power Supply

Note:

1. CS# must be driven high if chip is not selected. Please don't leave CS# floating any time after power is on.



BLOCK DIAGRAM





3 MEMORY ORGANIZATION

GD55WR512ME

Each device has	Each block has	Each sector has	Each page has	
64M	64/32K	4K	256	Bytes
256K	256/128	16	-	pages
16K	16/8	-	-	sectors
1K/2K	-	-	-	blocks

UNIFORM BLOCK SECTOR ARCHITECTURE

GD55WR512ME 64K Bytes Block Sector Architecture

Block	Sector	Addres	s range
	16383	3FFF000H	3FFFFFH
1023			
	16368	3FF0000H	3FF0FFFH
	16367	3FEF000H	3FEFFFFH
1022			
	16352	3FE0000H	3FE0FFFH
	47	02F000H	02FFFFH
2			
	32	020000H	020FFFH
	31	01F000H	01FFFFH
1			
	16	010000H	010FFFH
	15	00F000H	00FFFFH
0			
	0	000000H	000FFFH

4 DEVICE OPERATIONS

4.1 SPI Mode

Standard SPI

The GD55WR512ME features a serial peripheral interface on 4 signals bus: Serial Clock (SCLK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Both SPI bus mode 0 and 3 are supported. Input data is latched on the rising edge of SCLK and data shifts out on the falling edge of SCLK.

Dual SPI

The GD55WR512ME supports Dual SPI operation when using the "Dual Output Fast Read", "Dual Output Fast Read with 4-Byte address", "Dual I/O Fast Read" and "Dual I/O Fast Read with 4-Byte address" commands (3BH, 3CH, BBH and BCH). These commands allow data to be transferred to or from the device at twice the rate of the standard SPI. When using the Dual SPI command, the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

Quad SPI

The GD55WR512ME supports Quad SPI operation when using the "Quad Output Fast Read", "Quad Output Fast Read", "Quad I/O Fast Read", "Quad I/O Fast Read with 4-Byte address" (6BH, 6CH, EBH, ECH) commands. These commands allow data to be transferred to or from the device at four times the rate of the standard SPI. When using the Quad SPI commands, the SI and SO pins become bidirectional I/O pins: IO0 and IO1, in addition to IO2 and IO3 pins. For GD55WR512ME, the QE bit is set to 1 as default and cannot be changed.

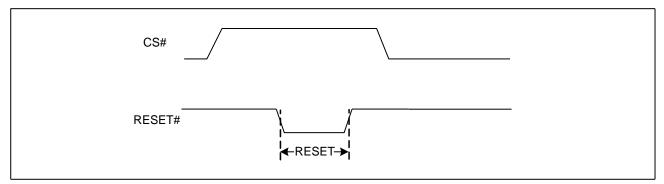
4.2 **RESET Function**

The RESET# pin goes low for a minimum period of tRLRH (1µs) will reset the flash. After reset cycle, the flash is at the following states:

-Standby mode

-All the volatile bits will return to the default status as power on.







5 DATA PROTECTION

The GD55WR512ME provide the following data protection methods:

Write Enable (WREN) command: The WREN command is set the Write Enable Latch bit (WEL). The WEL bit will
return to reset by the following situation:

-Power-Up / Software Reset (66H+99H)

-Write Disable (WRDI)

-Write Status Register (WRSR)

-Page Program (PP)

-Sector Erase (SE) / Block Erase (BE) / Chip Erase (CE)

- Software Protection Mode: The Block Protect bits (BP4-BP0) define the section of the memory array that can be read but not changed.
- Deep Power-Down Mode: In Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down Mode command and Software Reset (66H+99H).
- Write Inhibit Voltage (VWI): Device would reset automatically when VCC is below a certain threshold VWI.

 	Status Register Content Memory Content							
	Status I	Register	r Conter	nt		Memory Content	1	
BP4	BP3	BP2	BP1	BP0	Blocks	Addresses	Density	Portion
Х	0	0	0	0	NONE	NONE	NONE	NONE
0	0	0	0	1	1023	03FF0000h-03FFFFFh	64KB	Upper 1/1024
0	0	0	1	0	1022 to 1023	03FE0000h-03FFFFFh	128KB	Upper 1/512
0	0	0	1	1	1020 to 1023	03FC0000h-03FFFFFh	256KB	Upper 1/256
0	0	1	0	0	1016 to 1023	03F80000h-03FFFFFh	512KB	Upper 1/128
0	0	1	0	1	1008 to 1023	03F00000h-03FFFFFh	1MB	Upper 1/64
0	0	1	1	0	992 to 1023	03E00000h-03FFFFFh	2MB	Upper 1/32
0	0	1	1	1	960 to 1023	03C00000h-03FFFFFh	4MB	Upper 1/16
0	1	0	0	0	896 to 1023	03800000h-03FFFFFh	8MB	Upper 1/8
0	1	0	0	1	768 to 1023	03000000h-03FFFFFh	16MB	Upper 1/4
0	1	0	1	0	512 to 1023	02000000h-03FFFFFh	32MB	Upper 1/2
1	0	0	0	1	0	00000000h-0000FFFFh	64KB	Lower 1/1024
1	0	0	1	0	0 to 1	00000000h-0001FFFFh	128KB	Lower 1/512
1	0	0	1	1	0 to 3	00000000h-0003FFFFh	256KB	Lower 1/256
1	0	1	0	0	0 to 7	00000000h-0007FFFFh	512KB	Lower 1/128
1	0	1	0	1	0 to 15	00000000h-000FFFFFh	1MB	Lower 1/64
1	0	1	1	0	0 to 31	00000000h-001FFFFFh	2MB	Lower 1/32
1	0	1	1	1	0 to 63	00000000h-003FFFFFh	4MB	Lower 1/16
1	1	0	0	0	0 to 127	00000000h-007FFFFh	8MB	Lower 1/8
1	1	0	0	1	0 to 255	00000000h-00FFFFFh	16MB	Lower 1/4
1	1	0	1	0	0 to 511	00000000h-01FFFFFh	32MB	Lower 1/2
Х	1	1	Х	Х	ALL	00000000h-03FFFFFh	64MB	ALL
Х	1	0	1	1	ALL	00000000h-03FFFFFh	64MB	ALL

Table 3. GD55WR512ME Protected area size



6 **REGISTERS**

6.1 Status Register

No.	Name	Description	Note
S7 SRP0		Status Register Protection Bit	Non-volatile writable
S6	BP4	Block Protect Bit	Non-volatile writable
S5	BP3	Block Protect Bit	Non-volatile writable
S4	BP2	Block Protect Bit	Non-volatile writable
S3	BP1	Block Protect Bit	Non-volatile writable
S2 BP0		Block Protect Bit	Non-volatile writable
S1	WEL	Write Enable Latch	Volatile, read only
S0	WIP	Erase/Write In Progress	Volatile, read only

Table 4. Status Register-SR No.1

Table 5. Status Register-SR No.2

No.	Name	Description	Note
S15	SUS1	Erase Suspend Bit	Volatile, read only
S14	SRP1	Status Register Protection Bit	Non-volatile writable
S13	LB3	Security Register Lock Bit	Non-volatile writable (OTP)
S12	LB2	Security Register Lock Bit	Non-volatile writable (OTP)
S11	LB1	Security Register Lock Bit	Non-volatile writable (OTP)
S10	SUS2	Program Suspend Bit	Volatile, read only
S9	QE	Quad Enable Bit	QE = 1 permanently
S8	ADS	Current Address Mode Bit	Volatile, read only

Table 6. Status Register-SR No.3

No.	Name	Description	Note
S23	Reserved	Reserved	Reserved
S22	DRV1	Output Driver Strength Bit	Non-volatile writable
S21	DRV0	Output Driver Strength Bit	Non-volatile writable
S20	ADP	Power Up Address Mode Bit	Non-volatile writable
S19	EE	Erase Error Bit	Volatile, read only
S18	PE	Program Error Bit	Volatile, read only
S17	DC1	Dummy Configuration Bit	Non-volatile writable
S16	DC0	Dummy Configuration Bit	Non-volatile writable

The status and control bits of the Status Register are as follows:

WIP bit

The Write in Progress (WIP) bit indicates whether the memory is busy in program/erase/write status register progress. When

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WIP bit sets to 1, means the device is busy in program/erase/write status register progress, when WIP bit sets 0, means the device is not in program/erase/write status register progress.

WEL bit

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1 the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset and no Write Status Register, Program or Erase command is accepted.

BP4, BP3, BP2, BP1, BP0 bits

The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits are non-volatile. They define the size of the area to be software protected against Program and Erase commands. These bits are written with the Write Status Register (WRSR) command. When the Block Protect (BP4, BP3, BP2, BP1, BP0) bits are set to 1, the relevant memory area (as defined in Table 3) becomes protected against Page Program (PP), Sector Erase (SE), Block Erase (BE), and Chip Erase (CE) commands.

SRP1, SRP0 bits

The Status Register Protect (SRP1 and SRP0) bits are non-volatile Read/Write bits in the status register. The SRP bits control the method of write protection: software protection, power supply lock-down or one time programmable protection.

SRP1	SRP0	Status Register	Description
0	0	Software Protected	The Status Register can be written to after a Write Enable
0			command, WEL=1.(Default)
1	0	Device Supplied and Device (1)(2)	Status Register is protected and cannot be written to again until
1		Power Supply Lock-Down ⁽¹⁾⁽²⁾	the next Power-Down, Power-Up cycle.
1	1	$O_{12} \circ T_{122} \circ D_{12} \circ T_{122} \circ T_{12}^{(2)}$	Status Register is permanently protected and cannot be written
1	I	One Time Program ⁽²⁾	to.

NOTE:

1. When SRP1, SRP0= (1, 0), a Power-Down, Power-Up cycle will change SRP1, SRP0 to (0, 0) state.

2. This feature is available on special order. Please contact GigaDevice for details.

ADS bit

The Address Status (ADS) bit is a read only bit that indicates the current address mode the device is operating in. The device is in 3-Byte address mode when ADS=0 (default), and in 4-Byte address mode when ADS=1.

QE bit

The Quad Enable (QE) bit is a non-volatile bit in the Status Register that allows Quad operation. The default value of QE bit is 1 and it cannot be changed, so that the IO2 and IO3 pins are enabled all the time.

LB3, LB2, LB1 bits

The LB3, LB2 and LB1 bits are non-volatile One Time Program (OTP) bits in Status Register (S13, S12 and S11) that provide the write protect control and status to the Security Registers. The default state of LB3, LB2 and LB1 bits are 0, the security registers are unlocked. The LB3, LB2 and LB1 bits can be set to 1 individually using the Write Register instruction. The LB3, LB2 and LB1 bits are One Time Programmable, once they are set to 1, the Security Registers will become read-only permanently.



SUS1, SUS2 bits

The SUS1 and SUS2 bits are read only bits in the status register (S15 and S10) that are set to 1 after executing an Erase/ Program Suspend (75H) command (The Erase Suspend will set the SUS1 bit to 1, and the Program Suspend will set the SUS2 bit to 1). The SUS1 and SUS2 bits are cleared to 0 by Erase/Program Resume (7AH) command, software reset (66H+99H) command, as well as a power-down, power-up cycle.

DC1, DC0 bits

The Dummy Configuration (DC) bits are non-volatile, which select the number of dummy cycles between the end of address and the start of read data output. Dummy cycles provide additional latency that is needed to complete the initial read access of the flash array before data can be returned to the host system. Some read commands require additional dummy cycles as the SCLK frequency increases.

Command	DC1, DC0	Dummy Cycles	Freq.(MHz)
	00(default)	4	80
BBH, BCH	01	8	104R
ввп, всп	10	4	80
	11	8	104R
	00(default)	6	80
	01	10	104R
EBH, ECH	10	6	80
	11	10	104R

The following dummy cycle tables provide different dummy cycle settings that are configured.

Note:

1. "R" means VCC range=2.3V~3.6V.

PE bit

The Program Error (PE) bit is a read-only bit that indicates a program failure. It will also be set when the user attempts to program a protected array sector or access the locked OTP space. PE is cleared to "0" after program operation resumes.

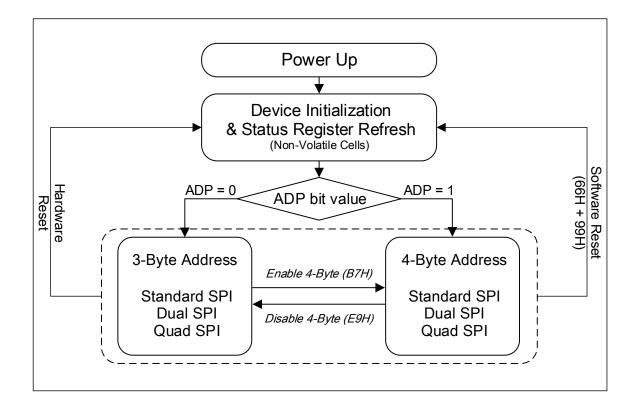
EE bit

The Erase Error (EE) bit is a read-only bit that indicates an erase failure. It will also be set when the user attempts to erase a protected array sector or access the locked OTP space. EE is cleared to "0" after erase operation resumes.

ADP bit

The Address Power-up (ADP) bit is a non-volatile writable bit that determines the initial address mode when the device is powered on or reset. This bit is only used during the power on or device reset initialization period. When ADP=0 (factory default), the device will power up into 3-Byte address mode, the Extended Address Register must be used to access memory regions beyond 128Mb. When ADP=1, the device will power up into 4-Byte address mode directly.





DRV1, DRV0 bits

The DRV1 and DRV0 bits are used to determine the output driver strength for the Read operations.

Table 7. Driver Strength for Read Operations

DRV1, DRV0	Driver Strength
00	100%
01	75% (default)
10	50%
11	25%

Reserved bit

It is recommended to set the value of the reserved bit as "0".



6.2 Extended Address Register

No.	Name	Description	Note
EA7	Reserved	Reserved	Reserved
EA6	Reserved	Reserved	Reserved
EA5	Reserved	Reserved	Reserved
EA4	Reserved	Reserved	Reserved
EA3	Reserved	Reserved	Reserved
EA2	Reserved	Reserved	Reserved
EA1	A25	Address bit	Volatile writable
EA0	A24	Address bit	Volatile writable

The bits of the Extended Address Register are as follows:

A25, A24 bit

The Extended Address Bits are used only when the device is operating in the 3-Byte Address Mode, which are volatile writable by C5H command.

A25, A24	Address
00	0000 0000h-00FF FFFFh
01	0100 0000h-01FF FFFFh
10	0200 0000h-02FF FFFFh
11	0300 0000h-03FF FFFFh

If the device powers up with ADP bit set to 1, or an "Enter 4-Byte Address Mode (B7H)" instruction is issued, the device will require 4-Byte address input for all address related instructions, and the Extended Address Bit setting will be ignored.

Reserved bit

It is recommended to set the value of the reserved bit as "0".



7 COMMAND DESCRIPTIONS

All commands, addresses and data are shifted in and out of the device, beginning with the most significant bit on the first rising edge of SCLK after CS# is driven low. Then, the one-byte command code must be shifted in to the device, with most significant bit first on SI, and each bit is latched on the rising edges of SCLK.

Every command sequence starts with a one-byte command code. Depending on the command, this might be followed by address bytes, or by data bytes, or by both or none. CS# must be driven high after the last bit of the command sequence has been completed. For the command of Read, Fast Read, Read Status Register or Release from Deep Power-Down, and Read Device ID, the shifted-in command sequence is followed by a data-out sequence. All read instruction can be completed after any bit of the data-out sequence is being shifted out, and then CS# must be driven high to return to deselected status.

For the command of Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register, Write Enable, Write Disable or Deep Power-Down command, CS# must be driven high exactly at a byte boundary, otherwise the command is rejected, and is not executed. That is CS# must be driven high when the number of clock pulses after CS# being driven low is an exact multiple of eight. For Page Program, if at any time the input byte is not a full byte, nothing will happen and WEL will not be reset.

Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8	Byte 9
Write Enable	06H								
Write Disable	04H								
Read Status Register- 1	05H	(S7-S0)	(cont.)						
Read Status Register- 2	35H	(S15-S8)	(cont.)						
Read Status Register- 3	15H	(S23-S16)	(cont.)						
Write Status Register-1	01H	S7-S0							
Write Status Register-2	31H	S15-S8							
Write Status Register-3	11H	S23-S16							
Read Extended Addr. Register	C8H	(EA7- EA0)							
Write Extended Addr. Register	C5H	EA7-EA0							
Volatile SR write Enable	50H								
Set Burst with Wrap	77H	dummy ⁽¹⁾	dummy ⁽¹⁾	dummy ⁽¹⁾	W7-W0 ⁽¹⁾				
Chip Erase	C7H/60H								
Enter 4-Byte Address Mode	B7H								

Table 9. Commands (3- or 4-Byte Addr. Mode)



Uniform Sector GigoDevice Dual and Quad Serial Flash

GD55WR512ME

Exit 4-Byte Address									
Mode	E9H								
Read Manufacturer/					(MID7-				
Device ID	90H	00H	00H	00H	MID0)	(ID7-ID0)	(cont.)		
Read Identification	9FH	(MID7- MID0)	(ID15-ID8)	(ID7-ID0)	(cont.)				
Enable Reset	66H								
Reset	99H								
Program/Erase Suspend	75H								
Program/Erase Resume	7AH								
Deep Power-Down	B9H								
Release From Deep Power-Down	ABH								
Release From Deep Power-Down and Read Device ID	ABH	dummy	dummy	dummy	(ID7-ID0)	(cont.)			
Read Serial Flash Discoverable Parameter	5AH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)		
Read Data with 4-Byte Address	13H	A31-A24	A23-A16	A15-A8	A7-A0	(D7-D0)	(cont.)		
Fast Read with 4-Byte Address	0CH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)	
Fast Read Dual Output with 4-Byte Address	3CH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽²⁾	(cont.)	
Fast Read Quad Output with 4-Byte Address	6CH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽³⁾	(cont.)	
Fast Read Dual I/O with 4-Byte Address	BCH	A31-A24 ⁽⁴⁾	A23-A16 ⁽⁴⁾	A15-A8 ⁽⁴⁾	A7-A0 ⁽⁴⁾	M7-M0 ⁽⁵⁾	(D7-D0) ⁽²⁾	(cont.)	
Fast Read Quad I/O with 4-Byte Address	ECH	A31-A24 ⁽⁶⁾	A23-A16 ⁽⁶⁾	A15-A8 ⁽⁶⁾	A7-A0 ⁽⁶⁾	M7-M0 ⁽⁷⁾	dummy	dummy	(D7- D0) ⁽³⁾
Page Program with 4- Byte Address	12H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte		
Quad Page Program with 4-Byte Address	34H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0 ⁽⁸⁾	Next Byte		
Sector Erase with 4- Byte Address	21H	A31-A24	A23-A16	A15-A8	A7-A0				
Block Erase (32K) with 4-Byte Address	5CH	A31-A24	A23-A16	A15-A8	A7-A0				

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Block Erase (64K) with 4-Byte Address	DCH	A31-A24	A23-A16	A15-A8	A7-A0				
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Table 10. Commands (3-Byte Addr. Mode)

Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8	Byte 9
Read Data	03H	A23-A16	A15-A8	A7-A0	(D7-D0)	(cont.)			
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)		
Dual Output Fast Read	3BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽²⁾	(cont.)		
Quad Output Fast Read	6BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽³⁾	(cont.)		
Dual I/O Fast Read	BBH	A23-A16 ⁽⁹⁾	A15-A8 ⁽⁹⁾	A7-A0 ⁽⁹⁾	M7-M0 ⁽⁵⁾	(D7-D0) ⁽²⁾	(cont.)		
Quad I/O Fast Read	EBH	A23- A16 ⁽¹⁰⁾	A15-A8 ⁽¹⁰⁾	A7-A0 ⁽¹⁰⁾	M7-M0 ⁽⁷⁾	dummy	dummy	(D7-D0) ⁽³⁾	(cont.)
Page Program	02H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte			
Quad Page Program	32H	A23-A16	A15-A8	A7-A0	D7-D0 ⁽⁸⁾	Next Byte			
Sector Erase	20H	A23-A16	A15-A8	A7-A0					
Block Erase (32K)	52H	A23-A16	A15-A8	A7-A0					
Block Erase (64K)	D8H	A23-A16	A15-A8	A7-A0					
Read Unique ID	4BH	00H	00H	00H	dummy	(UID7- UID0)	(cont.)		
Erase Security Registers ⁽¹¹⁾	44H	A23-A16	A15-A8	A7-A0					
Program Security Registers ⁽¹¹⁾	42H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte			
Read Security Registers ⁽¹¹⁾	48H	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)		

Table 11. Commands (4-Byte Addr. Mode)

Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8	Byte 9
03H	A31-A24	A23-A16	A15-A8	A7-A0	(D7-D0)	(cont.)		
0BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)	
3BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽²⁾	(cont.)	
6BH	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽³⁾	(cont.)	
BBH	A31-A24 ⁽⁴⁾	A23-A16 ⁽⁴⁾	A15-A8 ⁽⁴⁾	A7-A0 ⁽⁴⁾	M7-M0 ⁽⁵⁾	(D7-D0) ⁽²⁾	(cont.)	
EBH	A31-A24 ⁽⁶⁾	A23-A16 ⁽⁶⁾	A15-A8 ⁽⁶⁾	A7-A0 ⁽⁶⁾	M7-M0 ⁽⁶⁾	dummy	dummy	(D7- D0) ⁽³⁾
02H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte		
32H	A31-A24 ⁽⁶⁾	A23-A16 ⁽⁶⁾	A15-A8 ⁽⁶⁾	A7-A0 ⁽⁶⁾	D7-D0 ⁽⁸⁾	Next Byte		
	03H 0BH 3BH 6BH BBH EBH 02H	03H A31-A24 0BH A31-A24 3BH A31-A24 6BH A31-A24 BBH A31-A24 BBH A31-A24 BBH A31-A24 02H A31-A24	03H A31-A24 A23-A16 0BH A31-A24 A23-A16 3BH A31-A24 A23-A16 3BH A31-A24 A23-A16 6BH A31-A24 A23-A16 BBH A31-A24 A23-A16 BBH A31-A24 ⁽⁴⁾ A23-A16 ⁽⁴⁾ EBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ 02H A31-A24 A23-A16	O3H A31-A24 A23-A16 A15-A8 OBH A31-A24 A23-A16 A15-A8 3BH A31-A24 A23-A16 A15-A8 3BH A31-A24 A23-A16 A15-A8 6BH A31-A24 A23-A16 A15-A8 BBH A31-A24 A23-A16 A15-A8 BBH A31-A24 ⁽⁴⁾ A23-A16 ⁽⁴⁾ A15-A8 ⁽⁴⁾ BBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ A15-A8 ⁽⁶⁾ EBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ A15-A8 ⁽⁶⁾ 02H A31-A24 A23-A16 A15-A8	O3H A31-A24 A23-A16 A15-A8 A7-A0 OBH A31-A24 A23-A16 A15-A8 A7-A0 3BH A31-A24 A23-A16 A15-A8 A7-A0 3BH A31-A24 A23-A16 A15-A8 A7-A0 6BH A31-A24 A23-A16 A15-A8 A7-A0 6BH A31-A24 A23-A16 A15-A8 A7-A0 BBH A31-A24 A23-A16 A15-A8 A7-A0 BBH A31-A24 ⁽⁴⁾ A23-A16 ⁽⁴⁾ A15-A8 ⁽⁴⁾ A7-A0 ⁽⁴⁾ EBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ A15-A8 ⁽⁶⁾ A7-A0 ⁽⁶⁾ 02H A31-A24 A23-A16 A15-A8 A7-A0	O3H A31-A24 A23-A16 A15-A8 A7-A0 (D7-D0) OBH A31-A24 A23-A16 A15-A8 A7-A0 dummy 3BH A31-A24 A23-A16 A15-A8 A7-A0 dummy 3BH A31-A24 A23-A16 A15-A8 A7-A0 dummy 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy BBH A31-A24 ⁽⁴⁾ A23-A16 ⁽⁴⁾ A15-A8 ⁽⁴⁾ A7-A0 ⁽⁴⁾ M7-M0 ⁽⁵⁾ EBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ A15-A8 ⁽⁶⁾ A7-A0 ⁽⁶⁾ M7-M0 ⁽⁶⁾ 02H A31-A24 A23-A16 A15-A8 A7-A0 D7-D0	O3H A31-A24 A23-A16 A15-A8 A7-A0 (D7-D0) (cont.) OBH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) 3BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) 3BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ BBH A31-A24 ⁽⁴⁾ A23-A16 ⁽⁴⁾ A15-A8 ⁽⁴⁾ A7-A0 ⁽⁴⁾ M7-M0 ⁽⁵⁾ (D7-D0) ⁽²⁾ EBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ A15-A8 ⁽⁶⁾ A7-A0 ⁽⁶⁾ M7-M0 ⁽⁶⁾ dummy 02H A31-A24 A23-A16 A15-A8 A7-A0 D7-D0 Next Byte	O3H A31-A24 A23-A16 A15-A8 A7-A0 (D7-D0) (cont.) OBH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) (cont.) OBH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) (cont.) 3BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ (cont.) 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ (cont.) 6BH A31-A24 A23-A16 A15-A8 A7-A0 dummy (D7-D0) ⁽²⁾ (cont.) BBH A31-A24 ⁽⁴⁾ A23-A16 ⁽⁴⁾ A15-A8 ⁽⁴⁾ A7-A0 ⁽⁴⁾ M7-M0 ⁽⁵⁾ (D7-D0) ⁽²⁾ (cont.) EBH A31-A24 ⁽⁶⁾ A23-A16 ⁽⁶⁾ A15-A8 ⁽⁶⁾ A7-A0 ⁽⁶⁾ M7-M0 ⁽⁶⁾ dummy dummy 02H A31-A24 A23-A16 A15-A8 A7-A0 D7-D0 Next Byte

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Sector Erase	20H	A31-A24	A23-A16	A15-A8	A7-A0				
Block Erase (32K)	52H	A31-A24	A23-A16	A15-A8	A7-A0				
Block Erase (64K)	D8H	A31-A24	A23-A16	A15-A8	A7-A0				
Read Unique ID	4BH	00H	00H	00H	00H	dummy	(UID7- UID0)	(cont.)	
Erase Security Registers ⁽¹¹⁾	44H	A31-A24	A23-A16	A15-A8	A7-A0				
Program Security Registers ⁽¹¹⁾	42H	A31-A24	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte		
Read Security Registers ⁽¹¹⁾	48H	A31-A24	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)	

Note:

1. Dummy bits and Wrap Bits IO0 = (x, x, x, x, x, x, W4, x)IO1 = (x, x, x, x, x, x, W5, x)IO2 = (x, x, x, x, x, x, W6, x)IO3 = (x, x, x, x, x, x, x, x, x)2. Dual Output data IO0 = (D6, D4, D2, D0)IO1 = (D7, D5, D3, D1) 3. Quad Output Data IO0 = (D4, D0, ...) IO1 = (D5, D1, ...) IO2 = (D6, D2, ...) IO3 = (D7, D3, ...) 4. Dual Input 4-Byte Address IO0 = A30, A28, A26, A24, A22, A20, A18, A16, A14, A12, A10, A8 A6, A4, A2, A0 IO1 = A31, A29, A27, A25, A23, A21, A19, A17, A15, A13, A11, A9 A7, A5, A3, A1 5. Dual Input Mode bit IO0 = M6, M4, M2, M0 IO1 = M7, M5, M3, M1 6. Quad Input 4-Byte Address IO0 = A28, A24, A20, A16, A12, A8, A4, A0 IO1 = A29, A25, A21, A17, A13, A9, A5, A1 IO2 = A30, A26, A22, A18, A14, A10, A6, A2 IO3 = A31, A27, A23, A19, A15, A11, A7, A3 7. Quad Input Mode bit IO0 = M4, M0 IO1 = M5, M1 IO2 = M6, M2 IO3 = M7, M3 8. Quad Output Data IO0 = D4, D0, ... GD55WR512ME-Rev1.1

IO1 = D5, D1, ... IO2 = D6, D2, ... IO3 = D7, D3, ... 9. Dual Input Address IO0 = A22, A20, A18, A16, A14, A12, A10, A8 A6, A4, A2, A0 IO1 = A23, A21, A19, A17, A15, A13, A11, A9 A7, A5, A3, A1 10. Quad Input Address IO0 = A20, A16, A12, A8, A4, A0 IO1 = A21, A17, A13, A9, A5, A1 IO2 = A22, A18, A14, A10, A6, A2 IO3 = A23, A19, A15, A11, A7, A3 11. Security Registers Address Security Register1: A23-A16=00H, A15-A12=1H, A11 = 0b, A10-A0= Byte Address; Security Register2: A23-A16=00H, A15-A12=2H, A11 = 0b, A10-A0= Byte Address; Security Register3: A23-A16=00H, A15-A12=3H, A11 = 0b, A10-A0= Byte Address;

TABLE OF ID DEFINITIONS

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Operation Code	MID7-MID0	ID15-ID8	ID7-ID0
9FH	C8	65	1A
90H	C8		19
ABH			19



7.1 Write Enable (WREN) (06H)

The Write Enable (WREN) command is for setting the Write Enable Latch (WEL) bit. The Write Enable Latch (WEL) bit must be set prior to every Page Program (PP), Quad Page Program (QPP), Sector Erase (SE), Block Erase (BE), Chip Erase (CE), Write Status Register (WRSR) and Erase/Program Security Registers command.

The Write Enable (WREN) command sequence: CS# goes low \rightarrow sending the Write Enable command \rightarrow CS# goes high.

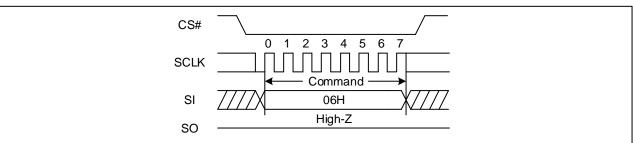


Figure 4. Write Enable Sequence Diagram

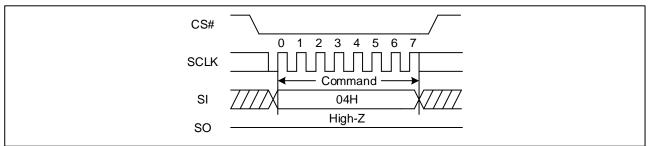
7.2 Write Disable (WRDI) (04H)

The Write Disable command is for resetting the Write Enable Latch (WEL) bit. The Write Enable Latch (WEL) bit may be set to 0 by issuing the Write Disable (WRDI) command to disable Page Program (PP), Quad Page Program (QPP), Sector Erase (SE), Block Erase (BE), Chip Erase (CE), Write Status Register (WRSR), that require WEL be set to 1 for execution. The WRDI command can be used by the user to protect memory areas against inadvertent writes that can possibly corrupt the contents of the memory. The WRDI command is ignored during an embedded operation while WIP bit =1.

The WEL bit is reset by following condition: Write Disable command (WRDI), Power-up, and upon completion of the Write Status Register, Page Program, Sector Erase, Block Erase and Chip Erase commands.

The Write Disable command sequence: CS# goes low \rightarrow Sending the Write Disable command \rightarrow CS# goes high.

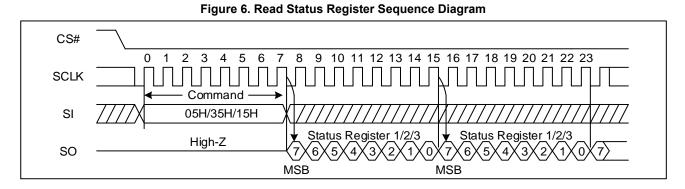
Figure 5. Write Disable Sequence Diagram



7.3 Read Status Register (RDSR) (05H/35H/15H)

The Read Status Register (RDSR) command is for reading the Status Register. The Status Register may be read at any time, even while a Program, Erase or Write Status Register cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write in Progress (WIP) bit before sending a new command to the device. It is also possible to read the Status Register continuously. For command code of "05H" / "35H" / "15H", the SO will output Status Register bits S7~S0 / S15~S8 / S23~S16.



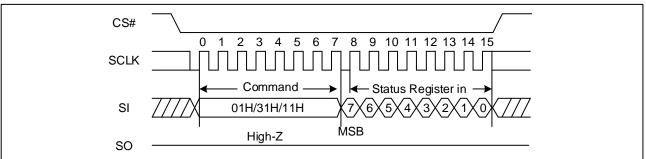


7.4 Write Status Register (WRSR) (01H/31H/11H)

The Write Status Register (WRSR) command allows new values to be written to the Status Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL).

The Write Status Register (WRSR) command has no effect on S19, S18, S15, S10, S9, S8, S1 and S0 of the Status Register. For command code of "01H" / "31H" / "11H", the Status Register bits S7~S0 / S15~S8 / S23~S16 would be written. CS# must be driven high after the eighth bit of the data byte has been latched in. Otherwise, the Write Status Register (WRSR) command is not executed. As soon as CS# is driven high, the self-timed Write Status Register cycle (whose duration is tw) is initiated. While the Write Status Register cycle is in progress, the Status Register may still be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Write Status Register cycle, and is 0 when it is completed. When the cycle is completed, the Write Enable Latch (WEL) is reset.

The Write Status Register (WRSR) command allows the user to change the values of the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits, to define the size of the area that is to be treated as read-only.



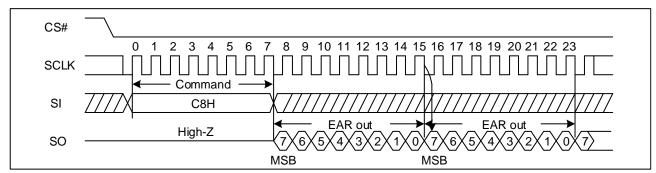


7.5 Read Extended Address Register (C8H)

The Read Extended Address Register instruction is entered by driving CS# low and shifting the instruction code "C8H" into the SI pin on the rising edge of SCLK. The Extended Register bits are then shifted out on the SO pin at the falling edge of SCLK with most significant bit (MSB) first.



Figure 8 Read Extended Address Register Sequence Diagram

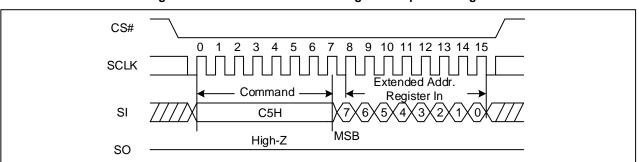


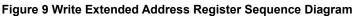
7.6 Write Extended Address Register (C5H)

The Write Extended Address Register instruction allows new Address bit values to be written to the Extended Address Register. A Write Enable (WREN) instruction must be executed previously to set the Write Enable Latch (WEL) bit before it can be accepted.

The Write Extended Address Register instruction is entered by driving CS# low, sending the instruction code "C5H", and then writing the Extended Register data Byte.

Upon power up or the execution of a Software/Hardware Reset, the Extended Address Register bit values will be cleared to 0.





7.7 Write Enable for Volatile Status Register (50H)

The non-volatile Status Register bits can also be written to as volatile bits. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. The Write Enable for Volatile Status Register command must be issued prior to a Write Status Register command and any other commands can't be inserted between them. Otherwise, Write Enable for Volatile Status Register command will not set the Write Enable for Volatile Latch bit, it is only valid for the Write Status Register command to change the volatile Status Register bit values.



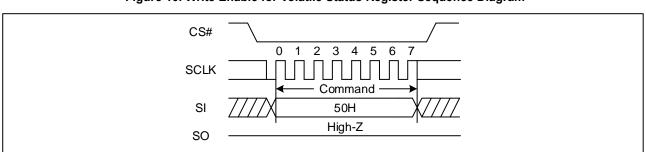
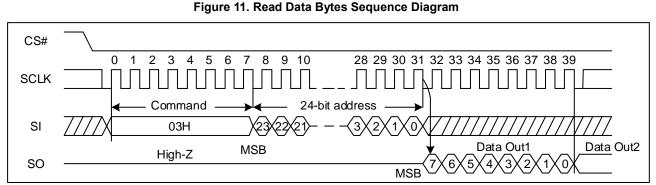


Figure 10. Write Enable for Volatile Status Register Sequence Diagram

7.8 Read Data Bytes (03H/13H)

The Read Data Bytes (READ) command is followed by a 3/4-Byte address, and each bit being latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit being shifted out, at a Max frequency f_R , on the falling edge of SCLK. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out. The whole memory can, therefore, be read with a single Read Data Bytes (READ) command. Any Read Data Bytes (READ) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

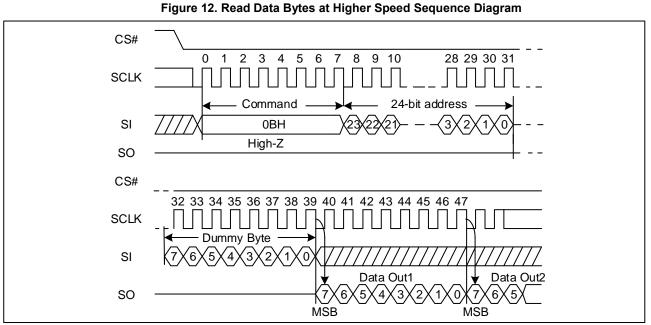


Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.9 Read Data Bytes at Higher Speed (0BH/0CH)

The Read Data Bytes at Higher Speed (Fast Read) command is for quickly reading data out. It is followed by a 3/4-Byte address and a dummy Byte, and each bit being latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit being shifted out, at a Max frequency f_C, on the falling edge of SCLK. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.





Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.10 Dual Output Fast Read (3BH/3CH)

The Dual Output Fast Read command is followed by 3/4-Byte address and a dummy Byte, and each bit being latched in on the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO.

The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.

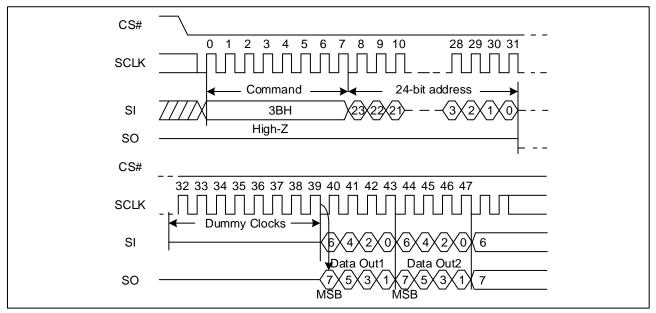


Figure 13. Dual Output Fast Read Sequence Diagram

Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

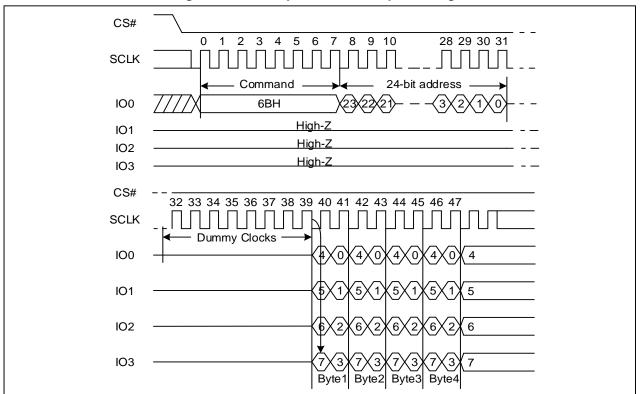
7.11 Quad Output Fast Read (6BH/6CH)

The Quad Output Fast Read command is followed by 3/4-Byte address and a dummy Byte, and each bit being latched in

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on the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO3, IO2, IO1 and IO0. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.





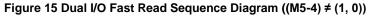
7.12 Dual I/O Fast Read (BBH/BCH)

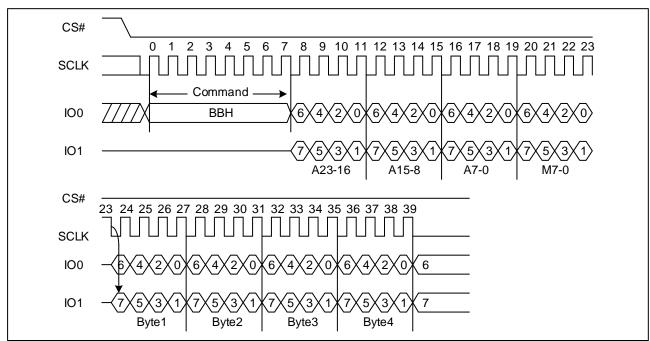
The Dual I/O Fast Read command is similar to the Dual Output Fast Read command but with the capability to input the 3/4-Byte address and a "Continuous Read Mode" Byte 2-bit per clock by SI and SO, and each bit being latched in on the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.

"Continuous Read Mode" bits must NOT be set as (M5-4) = (1, 0)

Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.





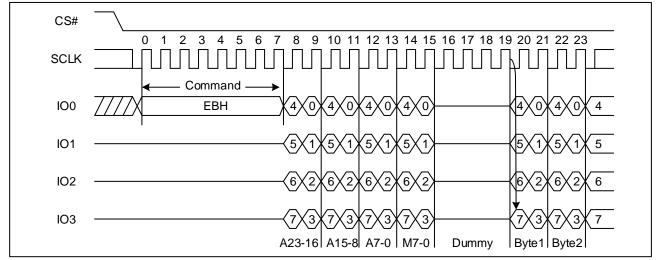


Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.13 Quad I/O Fast Read (EBH/ECH)

The Quad I/O Fast Read command is similar to the Quad Output Fast Read command but with the capability to input the 3/4-Byte address and a "Continuous Read Mode" Byte and 4-dummy clock 4-bit per clock by IO0, IO1, IO2, IO3, and each bit being latched in on the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO0, IO1, IO2, IO3. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.

"Continuous Read Mode" bits must NOT be set as (M5-4) = (1, 0)





Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

Quad I/O Fast Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Quad I/O Fast Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap"

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(77H) commands prior to EBH or ECH. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following EBH or ECH commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8/16/32/64-Byte section of a 256-Byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64-Byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-Byte) of data without issuing multiple read commands. The "Set Burst with Wrap" command allows three "Wrap Bits" W6-W4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-W5 is used to specify the length of the wrap around section within a page.

7.14 Set Burst with Wrap (77H)

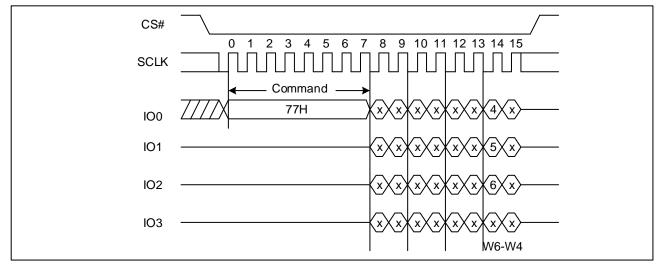
The Set Burst with Wrap command is used in conjunction with "Quad I/O Fast Read" command to access a fixed length of 8/16/32/64-byte section within a 256-byte page, in standard SPI mode.

The Set Burst with Wrap command sequence: CS# goes low \rightarrow Send Set Burst with Wrap command \rightarrow Send 24 dummy bits \rightarrow Send 8 bits "Wrap bits" \rightarrow CS# goes high.

W6,W5	W4=0		W4=1 (default)	
	Wrap Around	Wrap Length	Wrap Around	Wrap Length
0, 0	Yes	8-byte	No	N/A
0, 1	Yes	16-byte	No	N/A
1, 0	Yes	32-byte	No	N/A
1, 1	Yes	64-byte	No	N/A

If the W6-W4 bits are set by the Set Burst with Wrap command, all the following "Quad I/O Fast Read" command will use the W6-W4 setting to access the 8/16/32/64-byte section within any page. To exit the "Wrap Around" function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4=1.

Figure 17. Set Burst with Wrap Sequence Diagram



7.15 Page Program (PP 02H or 4PP 12H)

The Page Program (PP) command is for programming the memory. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command.

The Page Program (PP) command is entered by driving CS# Low, followed by the command code, three address Bytes

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and at least one data Byte on SI. If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the start address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven low for the entire duration of the sequence. The Page Program command sequence: CS# goes low \rightarrow sending Page Program command \rightarrow 3 or 4-Byte address on SI \rightarrow at least 1 Byte data on SI \rightarrow CS# goes high. If more than 256 Bytes are sent to the device, previously latched data are discarded and the last 256 data Bytes are guaranteed to be programmed correctly within the same page. If less than 256 data Bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other Bytes of the same page. CS# must be driven high after the eighth bit of the last data Byte has been latched in; otherwise the Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Page Program cycle (whose duration is t_{PP}) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Page Program (PP) command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

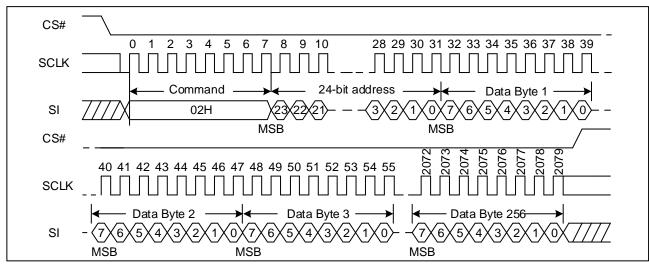


Figure 18 Page Program Sequence Diagram (ADS=0)

Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.16 Quad Page Program (32H/34H)

The Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The quad Page Program command is entered by driving CS# Low, followed by the command code (32H), three address Bytes and at least one data Byte on IO pins.

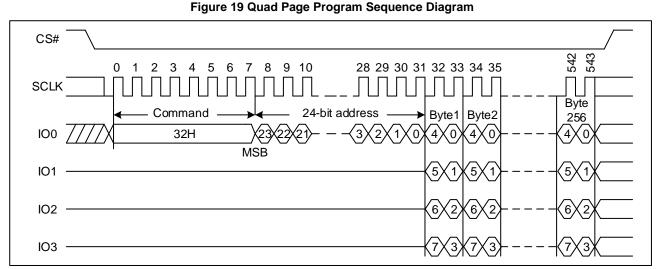
The command sequence is shown below. If more than 256 Bytes are sent to the device, previously latched data are discarded and the last 256 data Bytes are guaranteed to be programmed correctly within the same page. If less than 256 data Bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other Bytes of the same page. CS# must be driven high after the eighth bit of the last data Byte has been latched in; otherwise the Quad Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Quad Page Program cycle (whose duration is t_{PP}) is initiated. While the Quad Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Quad Page Program cycle, and is 0 when it is completed. At some

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unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

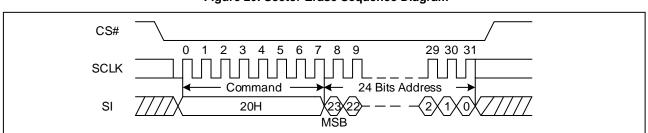


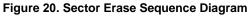
Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.17 Sector Erase (SE 20H or 4SE 21H)

The Sector Erase (SE) command is erased the all data of the chosen sector. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The Sector Erase (SE) command is entered by driving CS# low, followed by the command code, and 3- or 4-address Byte on SI. Any address inside the sector is a valid address for the Sector Erase (SE) command. CS# must be driven low for the entire duration of the sequence.

The Sector Erase command sequence: CS# goes low \rightarrow sending Sector Erase command \rightarrow 3-Byte or 4-Byte address on SI \rightarrow CS# goes high. CS# must be driven high after the eighth bit of the last address Byte has been latched in; otherwise the Sector Erase (SE) command is not executed. As soon as CS# is driven high, the self-timed Sector Erase cycle (whose duration is tsE) is initiated. While the Sector Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Sector Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A Sector Erase (SE) command applied to a sector which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bit is not executed.





Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.18 32KB Block Erase (BE32 52H or 4BE32 5CH)

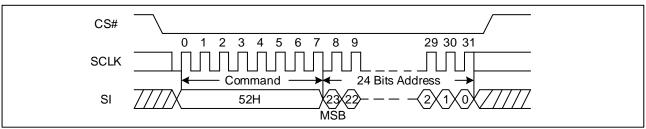
The 32KB Block Erase command is for erasing the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 32KB Block Erase command is entered by

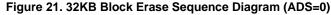
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driving CS# low, followed by the command code, and three address bytes on SI. Any address inside the block is a valid address for the 32KB Block Erase command. CS# must be driven low for the entire duration of the sequence.

The 32KB Block Erase command sequence: CS# goes low \rightarrow sending 32KB Block Erase command \rightarrow 3-Byte or 4-Byte address on SI \rightarrow CS# goes high. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 32KB Block Erase command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is t_{BE1}) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 32KB Block Erase command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits is not executed.



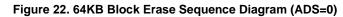


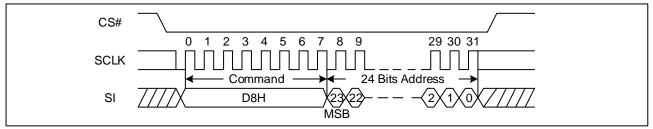
Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.19 64KB Block Erase (BE64 D8H or 4BE64 DCH)

The 64KB Block Erase command is for erasing the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 64KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and three address bytes on SI. Any address inside the block is a valid address for the 64KB Block Erase command. CS# must be driven low for the entire duration of the sequence.

The 64KB Block Erase command sequence: CS# goes low \rightarrow sending 64KB Block Erase command \rightarrow 3-Byte or 4-Byte address on SI \rightarrow CS# goes high. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 64KB Block Erase command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is t_{BE2}) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 64KB Block Erase command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits is not executed.





Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.20 Chip Erase (CE) (60H/C7H)

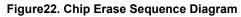
The Chip Erase (CE) command is for erasing the all data of the chip. A Write Enable (WREN) command must previously

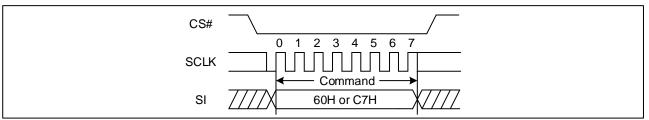
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have been executed to set the Write Enable Latch (WEL) bit .The Chip Erase (CE) command is entered by driving CS# Low, followed by the command code on Serial Data Input (SI). CS# must be driven Low for the entire duration of the sequence.

The Chip Erase command sequence: CS# goes low \rightarrow sending Chip Erase command \rightarrow CS# goes high. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Chip Erase command is not executed. As soon as CS# is driven high, the self-timed Chip Erase cycle (whose duration is t_{CE}) is initiated. While the Chip Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Chip Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Chip Erase (CE) command is executed, if the no block is protected by the Block Protect bits. The Chip Erase (CE) command is ignored if one or more sectors are protected.





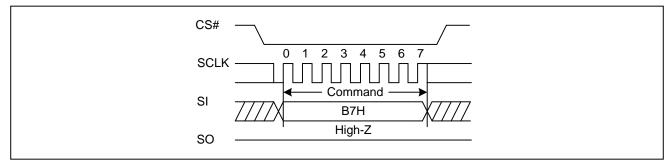
7.21 Enter 4-Byte Address Mode (EN4B) (B7H)

The Enter 4-Byte Address Mode command enables accessing the address length of 32-bit for the memory area of higher density (larger than 128Mb). The device default is in 24-bit address mode; after sending out the EN4B instruction, the bit8 (ADS bit) of status register will be automatically set to "1" to indicate the 4-Byte address mode has been enabled. Once the 4-Byte address mode is enabled, the address length becomes 32-bit instead of the default 24-bit.

All instructions are accepted normally, and just the address bit is changed from 24-bit to 32-bit.

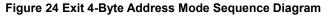
The sequence of issuing EN4B instruction is: CS# goes low \rightarrow sending Enter 4-Byte mode command \rightarrow CS# goes high.

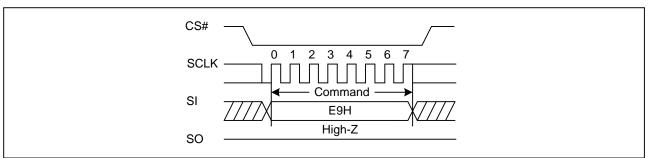
Figure 23 Enter 4-Byte Address Mode Sequence Diagram



7.22 Exit 4-Byte Address Mode (EX4B) (E9H)

The Exit 4-Byte Address Mode command is executed to exit the 4-Byte address mode and return to the default 3-Byte address mode. After sending out the EX4B instruction, the bit8 (ADS bit) of status register will be cleared to "0" to indicate the exit of the 4-Byte address mode. Once exiting the 4-Byte address mode, the address length will return to 24-bit. The sequence of issuing EX4B instruction is: CS# goes low \rightarrow sending Exit 4-Byte Address Mode command \rightarrow CS# goes high.





7.23 Read Manufacture ID/ Device ID (REMS) (90H)

The Read Manufacturer/Device ID command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID.

The command is initiated by driving the CS# pin low and shifting the command code "90H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first.

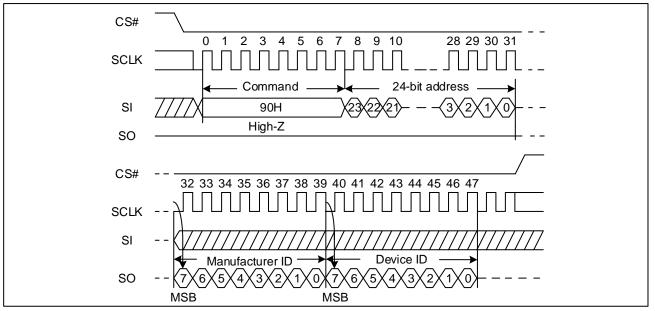


Figure 25. Read Manufacture ID/ Device ID Sequence Diagram

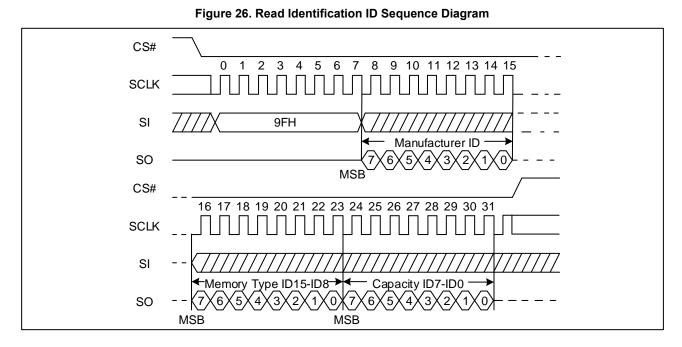
7.24 Read Identification (RDID) (9FH)

The Read Identification (RDID) command allows the 8-bit manufacturer identification to be read, followed by two bytes of device identification. The device identification indicates the memory type in the first byte, and the memory capacity of the device in the second byte. The Read Identification (RDID) command while an Erase or Program cycle is in progress, is not decoded, and has no effect on the cycle that is in progress. The Read Identification (RDID) command should not be issued while the device is in Deep Power-Down Mode.

The device is first selected by driving CS# low. Then, the 8-bit command code for the command is shifted in. This is followed by the 24-bit device identification, stored in the memory. Each bit is shifted out on the falling edge of Serial Clock. The Read Identification (RDID) command is terminated by driving CS# high at any time during data output. When CS# is driven high, the device is in the Standby Mode. Once in the Standby Mode, the device waits to be selected, so that it can receive, decode



and execute commands.



7.25 Read Unique ID (4BH)

The Read Unique ID command accesses a factory-set read-only 128bit number that is unique to each device. The Unique ID can be used in conjunction with user software methods to help prevent copying or cloning of a system.

The Read Unique ID command sequence: CS# goes low \rightarrow sending Read Unique ID command \rightarrow 3- or 4-Byte Address (000000H or 00000000H) \rightarrow Dummy Byte \rightarrow 128bit Unique ID Out \rightarrow CS# goes high.

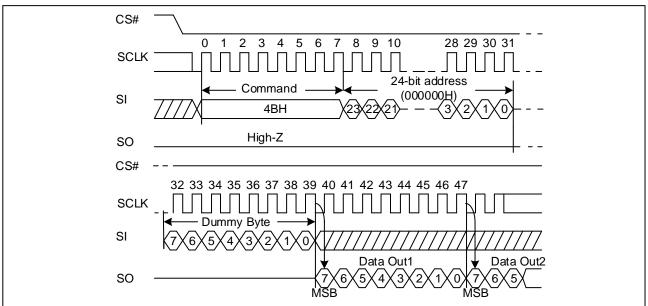


Figure 27. Read Unique ID Sequence Diagram

Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.26 Erase Security Registers (44H)

The GD55WR512ME provides 3x2048-Byte Security Registers which can be erased and programmed individually. These

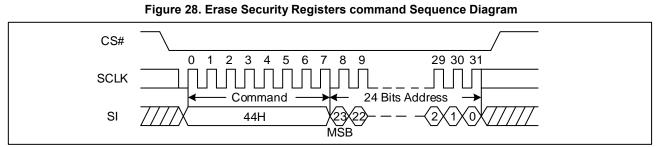
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registers may be used by the system manufacturers to store security and other important information separately from the main memory array.

The Erase Security Registers command is similar to Sector/Block Erase command. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit.

The Erase Security Registers command sequence: CS# goes low \rightarrow sending Erase Security Registers command \rightarrow 3- or 4-Byte address on SI \rightarrow CS# goes high. The command sequence is shown below. CS# must be driven high after the eighth bit of the last address Byte has been latched in; otherwise the Erase Security Registers command is not executed. As soon as CS# is driven high, the self-timed Erase Security Registers cycle (whose duration is t_{SE}) is initiated. While the Erase Security Registers cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Erase Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Security Registers Lock Bit (LB1, LB2, LB3) in the Status Register can be used to OTP protect the security registers. Once the LB bit is set to 1, the Security Registers will be permanently locked; the Erase Security Registers command will be ignored.

Address	A23-16	A15-12	A11	A10-0
Security Register #1	00H	0001b	0b	Don't care
Security Register #2	00H	0010b	0b	Don't care
Security Register #3	00H	0011b	0b	Don't care





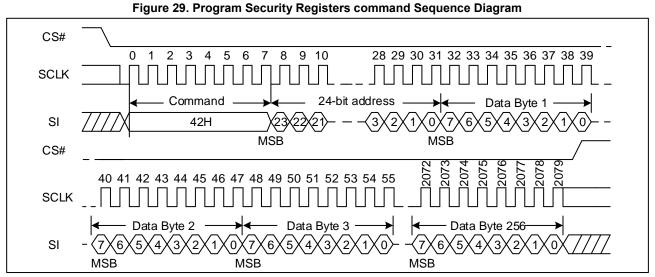
7.27 Program Security Registers (42H)

The Program Security Registers command is similar to the Page Program command. Each security register contains eight pages content. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Program Security Registers command. The Program Security Registers command is entered by driving CS# Low, followed by the command code (42H), three address Bytes and at least one data Byte on SI. As soon as CS# is driven high, the self-timed Program Security Registers cycle (whose duration is tPP) is initiated. While the Program Security Registers cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Program Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

If the Security Registers Lock Bit (LB1, LB2, LB3) is set to 1, the Security Registers will be permanently locked. Program Security Registers command will be ignored.

Address	A23-16	A15-12	A11	A10-0
Security Register #1	00H	0001b	0b	Byte Address
Security Register #2	00H	0010b	0b	Byte Address
Security Register #3	00H	0011b	0b	Byte Address





Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit.

7.28 Read Security Registers (48H)

The Read Security Registers command is similar to Fast Read command. The command is followed by a 3- or 4-Byte address (A23-A0 or A31-A0) and a dummy Byte, and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency fc, on the falling edge of SCLK. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. Once the A10-0 address reaches the last byte of the register (Byte 7FFH), it will reset to 000H, the command is completed by driving CS# high.

Address	A23-16	A15-12	A11	A10-0
Security Register #1	00H	0001b	0b	Byte Address
Security Register #2	00H	0010b	0b	Byte Address
Security Register #3	00H	0011b	0b	Byte Address

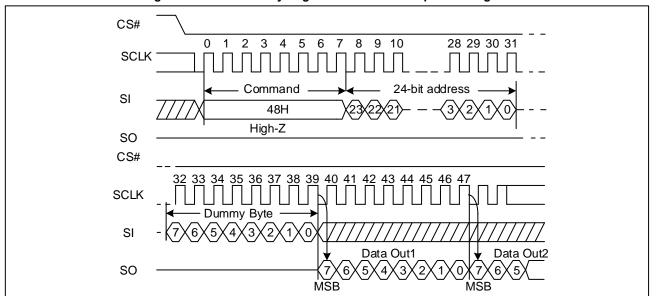


Figure 30. Read Security Registers command Sequence Diagram

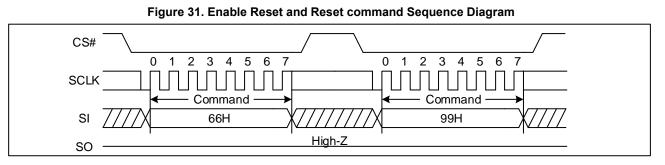
Note: The device default is in 24-bit address mode. For 4-Byte mode or 4-Byte command, the address length is 32-bit 36

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7.29 Enable Reset (66H) and Reset (99H)

If the Reset command is accepted, any on-going internal operation will be terminated and the device will return to its default power-on state and lose all the current volatile settings, such as Volatile Status Register bits, Write Enable Latch status (WEL), Program/Erase Suspend status, Read Parameter setting (P7-P0), Deep Power Down Mode, Continuous Read Mode bit setting (M7-M0) and Wrap Bit Setting (W6-W4).

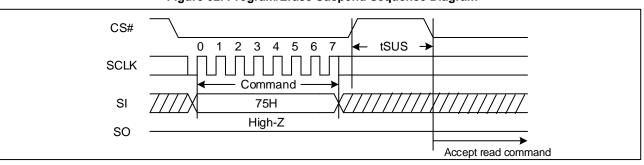
The "Enable Reset (66H)" and "Reset (99H)" command sequence as follow: CS# goes low \rightarrow Sending Enable Reset command \rightarrow CS# goes high \rightarrow CS# goes low \rightarrow Sending Reset command \rightarrow CS# goes high. Once the Reset command is accepted by the device, the device will take approximately t_{RST} / t_{RST_E} to reset. During this period, no command will be accepted. Data corruption may happen if there is an on-going or suspended internal Erase or Program operation when Reset command sequence is accepted by the device. It is recommended to check the WIP bit and the SUS1/SUS2 bit in Status Register before issuing the Reset command sequence.



7.30 Program/Erase Suspend (PES) (75H)

The Program/Erase Suspend command "75H", allows the system to interrupt a page program or sector/block erase operation and then read data from any other sector or block. The Write Status Register command (01H, 31H, 11H) and Erase/Program Security Registers command (44H, 42H) and Erase commands (20H, 21H, 52H, 5CH, D8H, DCH, C7H, 60H) and Page Program command (02H, 12H, 32H, 34H) are not allowed during Program suspend. The Write Status Register command (01H, 31H, 11H) and Erase Security Registers command (44H) and Erase commands (20H, 21H, 52H, 5CH, D8H, DCH, C7H, 60H) are not allowed during Erase suspend. Program/Erase Suspend is valid only during the page program or sector/block erase operation. A maximum of time of "tsus" (See AC Characteristics) is required to suspend the program/erase operation.

The Program/Erase Suspend command will be accepted by the device only if the SUS1/SUS2 bit in the Status Register equal to 0 and WIP bit equal to 1 while a Page Program or a Sector or Block Erase operation is on-going. If the SUS1/SUS2 bit equal to 1 or WIP bit equal to 0, the Suspend command will be ignored by the device. The WIP bit will be cleared from 1 to 0 within "tsus" and the SUS1/SUS2 bit will be set from 0 to 1 immediately after Program/Erase Suspend. A power-off during the suspend period will reset the device and release the suspend state.







7.31 Program/Erase Resume (PER) (7AH)

The Program/Erase Resume command must be written to resume the program or sector/block erase operation after a Program/Erase Suspend command. The Program/Erase Resume command will be accepted by the device only if the SUS1/SUS2 bit equal to 1 and the WIP bit equal to 0. After issued the SUS1/SUS2 bit in the status register will be cleared from 1 to 0 immediately, the WIP bit will be set from 0 to 1 within 200ns and the Sector or Block will complete the erase operation or the page will complete the program operation. The Program/Erase Resume command will be ignored unless a Program/Erase Suspend is active.

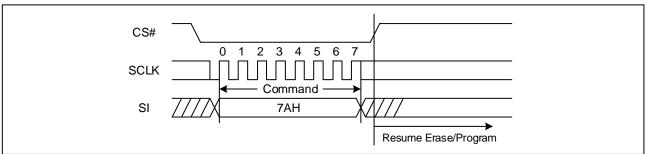




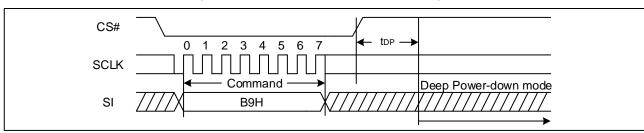
Figure 33. Program/Erase Resume Sequence Diagram

7.32 Deep Power-Down (DP) (B9H)

Executing the Deep Power-Down (DP) command is the only way to put the device in the lowest consumption mode (the Deep Power-Down Mode). It can also be used as an extra software protection mechanism, while the device is not in active use, since in this mode, the device ignores all Write, Program and Erase commands. Driving CS# high deselects the device, and puts the device in the Standby Mode (if there is no internal cycle currently in progress). But this mode is not the Deep Power-Down Mode. The Deep Power-Down Mode can only be entered by executing the Deep Power-Down (DP) command. Once the device has entered the Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down and Read Device ID (RDI) command or software reset command. The Release from Deep Power-Down and Read Device ID (RDI) command releases the device from Deep Power-Down mode, also allows the Device ID of the device to be output on SO.

The Deep Power-Down Mode automatically stops at Power-Down, and the device always in the Standby Mode after Power-Up.

The Deep Power-Down command sequence: CS# goes low \rightarrow sending Deep Power-Down command \rightarrow CS# goes high. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Deep Power-Down (DP) command is not executed. As soon as CS# is driven high, it requires a delay of top before the supply current is reduced to I_{CC2} and the Deep Power-Down Mode is entered. Any Deep Power-Down (DP) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.





7.33 Release from Deep Power-Down and Read Device ID (RDI) (ABH)

The Release from Power-Down and Read Device ID command is a multi-purpose command. It can be used to release the device from the Power-Down state or obtain the devices electronic identification (ID) number.

To release the device from the Power-Down state, the command is issued by driving the CS# pin low, shifting the instruction code "ABH" and driving CS# high. Release from Power-Down will take the time duration of t_{RES1} (See AC Characteristics) before the device will resume normal operation and other command are accepted. The CS# pin must remain high during the t_{RES1} time duration.

When used only to obtain the Device ID while not in the Power-Down state, the command is initiated by driving the CS# pin low and shifting the instruction code "ABH" followed by 3-dummy byte. The ID7~ID0 are then shifted out on the falling edge of SCLK with most significant bit (MSB) first. The Device ID value is listed in Manufacturer and Device Identification table. The Device ID can be read continuously. The command is completed by driving CS# high.

When used to release the device from the Power-Down state and obtain the ID7~ID0, the command is the same as previously described, except that after CS# is driven high it must remain high for a time duration of t_{RES2} (See AC Characteristics). After this time duration the device will resume normal operation and other command will be accepted. If the Release from Power-Down / Device ID command is issued while an Erase, Program or Write cycle is in process (when WIP equals 1) the command is ignored and will not have any effects on the current cycle.

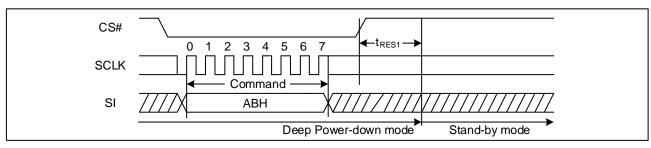
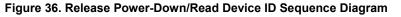
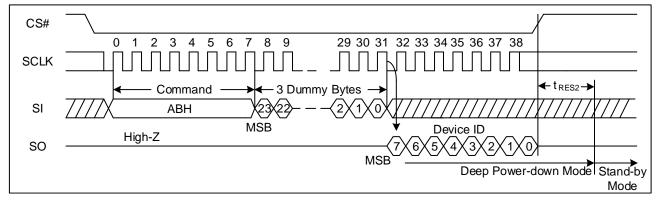


Figure 35. Release Power-Down Sequence Diagram





7.34 Read Serial Flash Discoverable Parameter (5AH)

The Serial Flash Discoverable Parameter (SFDP) standard provides a consistent method of describing the functional and feature capabilities of serial flash devices in a standard set of internal parameter tables. These parameter tables can be interrogated by host system software to enable adjustments needed to accommodate divergent features from multiple vendors. The concept is similar to the one found in the Introduction of JEDEC Standard, JESD68 on CFI. SFDP is a standard of JEDEC Standard No.216B.



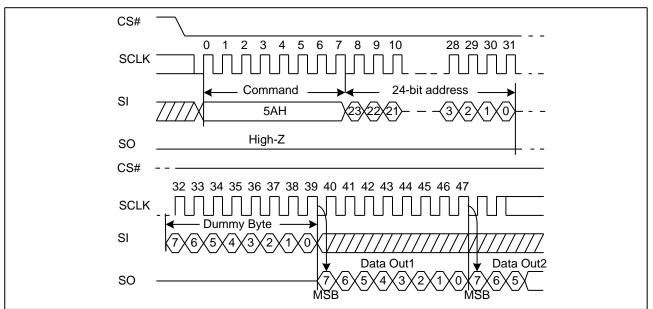


Figure 37. Read Serial Flash Discoverable Parameter command Sequence Diagram

Table 12. Signature and Parameter Identification Data Values (Please contact GigaDevice for Details)



8 RPMC COMMANDS DESCRIPTION

Function	Opcode	Payload Ph	ase Max 512 Bits	Comment
	Phase 8	Byte#	Field Description	
	bits			
Command: Write	OP1	1	CmdType[7:0] = 00H	OP1 + Payload phase driven by
Root Key Register		2	CounterAddr[7:0] = 8 Bits	host controller. Root Key
		3	Reserved[7:0] = 8 Bits	Register is written only once.
		4-35	RootKey[255:0] = 256 Bits	
		36-63	TruncatedSign[223:0] = 224 Bits	
Command: Update	OP1	1	CmdType[7:0]= 01H	OP1 + Payload phase is Issued
HMAC Key Register		2	CounterAddr[7:0]= 8 Bits	by host controller on every
		3	Reserved[7:0] = 8 Bits	power up to initialize HMAC Key
		4-7	KeyData[31:0] = 32 Bits,	Register.
		8-39	Signature[255:0] = 256 Bits	
Command: Increment	OP1	1	CmdType[7:0] = 02H	OP1 + Payload Phase is Issued
Monotonic Counter		2	CounterAddr[7:0] = 8 Bits	by host controller during runtime
		3	Reserved[7:0] = 8 Bits	to increment the counter.
		4-7	CounterData[31:0] = 32 Bits,	
		8-39	Signature[255:0] = 256 Bits	
Command: Request	OP1	1	CmdType[7:0] = 03H	OP1 + Payload Phase is Issued
Monotonic Counter		2	CounterAddr[7:0] = 8 Bits	by host controller during runtime
		3	Reserved[7:0] = 8 Bits Tag	to request counter data
		4-15	[95:0] = 96 Bits	
		16-47	Signature[255:0] = 256 Bits	
Command: Read	OP2	2	ExtendedStatus[7:0] = 8 Bits	OP2 is issued by Host Controller
Data		3-14	Tag[95:0] = 96 Bits	generally after an OP1. SPI
		15-18	CounterData[31:0] = 32 Bits	Flash device responds with the
		19-50	Signature[255:0] = 256 Bits	Payload phase to return
				Extended Status and counter
				data.

Table 13. Replay Protected Monotonic Counter (RPMC) Commands

All individual fields are Byte wide fields. For a multi-byte field, Most Significant Byte is issued first; Least Significant Byte is issued last. Within a Byte, Most Significant Bit is issued first; Least Significant Bit is issued last. CmdType is always the first byte issued after OP1 commands. OP2 delay is the same as Fast Read Command delay which is 8 dummy bits.

Byte #	0	1	2	3	4	5	6	 	
Name	OP1	CmdType	Counter	As defined in the table above					
			Address						
Name	OP2	8 Dummy	Extended	As defined in the table above					
		clocks	Status[7:0]						

Table 14. OP1 and OP2 are defined for 1-1-1 mode.

After an OP1 command is received, the SPI Flash will indicate status busy indication using either the status register or extended status register as defined below.



Extended	Applicable	Description				
Status[7:0]	CmdType(s)					
00000000	-	Power On State (OP2 issued directly after power-up).				
10000000	00,01,02,03	This status is set on successful completion (no errors) of OP1 command.				
0xxxxxx1	00,01,02,03,04-	This bit is set to 1, when device is busy executing OP1 command. It is reset to 0				
	0FF	when OP1 command execution is done.				
0xxxxx1x	00,01	This bit is set only when the correct payload size is received. When cmdtype = 0, this				
		error bit must be set on Root Key Register Overwrite or Counter Address out of range				
		or Truncated Signature mis-match error.				
		For cmdtype = 01 this bit is set when the corresponding monotonic counter is				
		uninitialized				
0xxxx1xx	00,01,02,03	This bit is set on Signature Mismatch, Counter Address out of range when correct				
		payload size is received; or Cmdtype is out of range; or incorrect payload size is				
		received.				
0xxx1xxx	02,03	This bit is set on HMAC Key Register or monotonic counter uninitialized on previous				
		OP1 command when correct payload size is received				
0xx1xxxx	02	This bit is set on Counter Data Mismatch on previous increment when correct				
		payload size is received				
0x1xxxxx	-	Fatal Error. It is set when no valid counter is found after initialization.				
Current		Extended status register will not be updated until first 8 bits of OP1 is received. The				
value		correct error type is reflected for any OP1 operation that exceeds a minimum of 16				
		clocks with active chip-select.				

8.1 Command: Write Root Key Register

This command is used to initialize the Root Key Register corresponding to the received Counter Address with the received Root Key. It is suggested to be used in an OEM manufacturing environment when the SPI Flash Controller and SPI Flash are powered together for the first time.

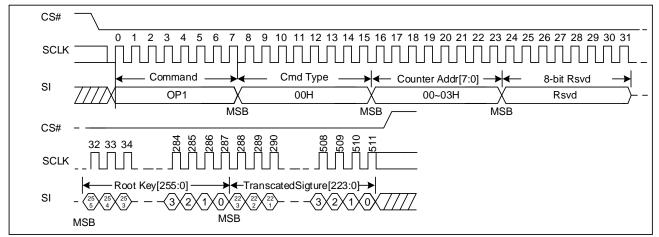


Figure 38. Write Root Key Register Sequence Diagram

Truncated signature field is the same as least significant 224 bits of HMAC-SHA-256 based signature computed based on



received input parameters:

- HMAC message[31:0] = (OpCode[7:0], CmdType[7:0], CounterAddr[7:0], Reserved[7:0])
- HMAC Key[255:0] = Root_Key[255:0]

If Root Key != 256'HFF..FF then this command can be executed one time. If the received transaction is error free SPI Flash device successfully executes the command and posts "successful completion" extended status.

Root Key Register Write with root key is = 256'HFF...FF can be used as a temporary key.

If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.

Extended	Applicable	Description
Status[7:0]	CmdType(s)	
1000000	00	Successful completion
0xxxxx1	00	If Busy_Polling_Method bit in SFDP table is zero, then this bit must be set to 1, when device is busy executing command. It is reset to 0 when OP1 command execution is done. If Busy_Polling_Method bit in SFDP table is one, then this bit is ignored by the controller.
0xxxxx1x	00	This bit is only set when correct payload size is received. It is set on Root Key Register Overwrite or Counter Address is out of range or when there is a truncated signature mismatch error
0xxxx1xx	00	This bit is set when incorrect payload size is received.

Table 16. Expected Extended Status [7:0] results

8.2 Command: Update HMAC Key Register

This command is used by the SPI Flash Controller to update the HMAC-Key register corresponding to the received Counter Address with a new HMAC key calculated based on received input. This command must be issued on every power cycle event on the interface. The HMAC key storage is volatile.

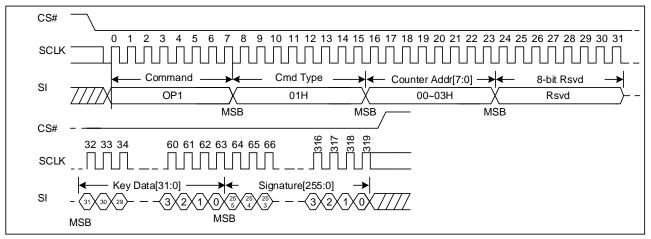


Figure 39. Update HMAC Key Register Sequence Diagram

Signature matches the HMAC-SHA-256 based signature computed based on received input parameters. This command performs two HMAC-SHA-256 operations.

- HMAC-SHA-256 Operation 1 Output = HMAC_Storage[255:0]
 - HMAC Message[31:0] = KeyData[31:0]
 - HMAC Key[255:0] = Root_Key_Register[CounterAddr][255:0]

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- HMAC-SHA-256 Operation 2 Output = HMAC-SHA-256 based signature[255:0]
 - HMAC message[63:0] = (OpCode[7:0], CmdType[7:0].CounterAddr[7:0].Reserved[7:0], KeyData[31:0])
 - HMAC Key[255:0] = HMAC_Storage[255:0]

If the received transaction is error free SPI Flash device successfully executes the command and posts "successful completion" extended status.

If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.

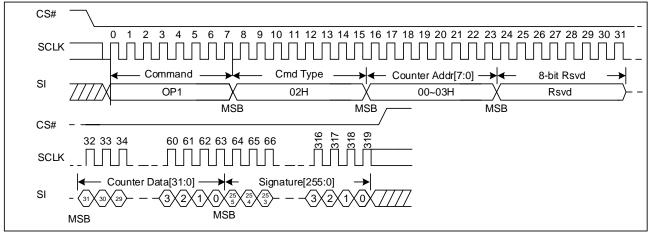
Extended	Applicable	Description
Status[7:0]	CmdType(s)	
1000000	01	This status is set on successful completion (no errors) of OP1 command.
0xxxxx1	01	This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.
0xxxxx1x	01	This bit is set only when the correct payload size is received. This bit is set when the corresponding monotonic counter is uninitialized
0xxxx1xx	01	This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or incorrect payload size is received.

Table 17. Expected Extended Status [7:0] results

8.3 Command: Increment Monotonic Counter

This command is used by the SPI Flash Controller to increment the Monotonic counter by 1 inside the SPI Flash Device.

Figure 40. Increment Monotonic Counter Sequence Diagram



The requested Signature matches the HMAC-SHA-256 based signature computed based on received input parameters. The received Counter Data matches the current value of the counter read from the SPI Flash.

- HMAC Message[63:0] = (OpCode[7:0], CmdType[7:0]. CounterAddr[7:0]. Reserved[7:0], CounterData[31:0])
- HMAC Key[255:0] = HMAC_Key_Register [Counter_Addreess][255:0]

If the received transaction is error free SPI Flash device successfully executes the command and posts "successful completion" extended status. If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.



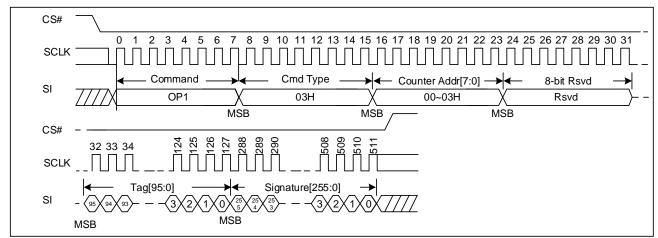
Extended	Applicable	Description
Status[7:0]	CmdType(s)	
1000000	02	This status is set on successful completion (no errors) of OP1
		command.
0xxxxxx1	02	This bit is set to 1, when device is busy executing OP1
		command. It is reset to 0 when OP1 command execution is
		done.
0xxxx1xx	02	This bit is set on Signature Mismatch, Counter Address out of
		range when correct payload size is received; or incorrect
		payload size is received.
0xxx1xxx	02	This bit is set only when the correct payload size is received.
		This bit must be set on HMAC Key Register or Monotonic
		Counter is uninitialized on previous OP1 command.
0xx1xxxx	02	This bit is set only when the correct payload size is received.
		The bit must be set when the received counter data filed does
		not match the actual counter value read from the SPI Flash
		device.

Table 18. Expected Extended Status [7:0] results

8.4 Command: Request Monotonic Counter

This command is used by the SPI Flash Controller to request the Monotonic counter value inside the SPI Flash Device.

Figure 41. Request Monotonic Counter Sequence Diagram



The requested Signature matches the HMAC-SHA-256 based signature computed based on received input parameters.

- HMAC Message[127:0] = (OpCode[7:0], CmdType[7:0]. CounterAddr[7:0]. Reserved[7:0], Tag[95:0])
- HMAC Key[255:0] = HMAC_Key_Register[Counter_Addreess][255:0]

If the received transaction is error free SPI Flash device successfully executes the command and posts "successful completion" extended status. If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.



Extended	Applicable	Description
Status[7:0]	CmdType(s)	
1000000	03	This status is set on successful completion (no errors) of OP1 command.
0xxxxx1	03	This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.
0xxxx1xx	03	This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or Cmdtype is out of range; or incorrect payload size is received.
0xxx1xxx	03	This bit is set only when the correct payload size is received. This bit must be set on HMAC Key Register or Monotonic Counter is uninitialized on previous OP1 command.

Table 19. Expected Extended Status [7:0] results

8.5 Command: Read Data

This command is used by the SPI Flash Controller to read extended status from any previously issued OP1 command. In addition if previous OP1 command is Request Monotonic Counter and if SPI Flash returns successful completion extended status then it returns valid values in the Tag, Counter Data and Signature field. Otherwise the values returned in Tag, Counter and Signature field are invalid. The controller may abort the read prematurely prior to completely reading the entire payload. This may occur when the controller wants to simply read the extended status or when is observes an error being returned in the extended status field. The controller may also continue reading past the defined payload size of 49 bytes. Since this is an error condition, the SPI Flash may return any data past the defined payload size. The controller must ignore the data.

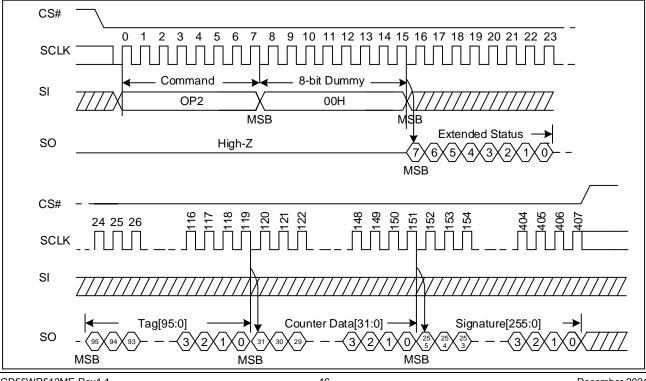


Figure 42. Read Data Sequence Diagram

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If previous OP1 command is Request Monotonic Counter and if SPI Flash returns successful completion extended status then it returns valid values in the Tag, Counter Data and Signature field. It calculates HMAC-SHA-256 signatures based on following parameters.

- HMAC Message[127:0] = Tag [95:0], Counter_Data_Read[31:0]
- HMAC Key[255:0] = HMAC_Key_Register[Counter_Address][255:0]

Table 20.	Extended	Status	Register	Definition
	=///	oluluo		

Extended	Applicable	Description
Status[7:0]	CmdType(s)	
0000000	-	Power On State (OP2 issued directly after power-up).
1000000	00, 01, 02, 03	This status is set on successful completion (no errors) of OP1
		command.
0xxxxx1	00, 01, 02, 03	This bit is set to 1, when device is busy executing OP1
		command. It is reset to 0 when OP1 command execution is done.
0xxxxx1x	00, 01	This bit is set only when the correct payload size is received. When
		cmdtype = 0, this error bit must be set on Root Key Register
		Overwrite or Counter Address out of range or Truncated Signature
		mis-match error.
		For remaining cmdtype = 1 this bit is set when the corresponding
		monotonic counter is uninitialized
0xxxx1xx 01, 02, 03		This bit is set on Signature Mismatch, Counter Address out of
		range when correct payload size is received; or Cmdtype is out of
		range; or incorrect payload size is received.
0xxx1xxx	02, 03	This bit is set on HMAC Key Register or Monotonic Counter
		uninitialized on previous OP1 command when correct payload size
		is received
0xx1xxxx	02	This bit is set on Counter Data Mismatch on previous increment
		when correct payload size is received
0x1xxxxx	-	Fatal Error. It is set when no valid counter is found after
		initialization.
Current value	-	Extended status register will not be updated until first 8 bits of OP1
		is received. The correct error type is reflected for any OP1
		operation that exceeds a minimum of 16 clocks with active chip-
		select.

8.6 Operations Allowed/Disallowed During RPMC Operation

In the deep power down state OP1, OP2 commands are ignored until the part comes out of deep power down state. WREN state does not affect the OP1 command execution inside the SPI Flash.

Suspend operation can be used to execute high-priority reads from the flash device while a long-latency operation is underway. However, OP1 is not recommended when the flash device is in WIP or suspended state.

In the table below, OP1 state is defined as the time starting with a transaction with OP1 op-code sent to the device and ending when the device clears the extended status busy bit. During OP1 state if a suspend transaction is received, the SPI Flash will ignore the suspend command and continue with the execution of the current OP1 command as described in the table below. P/E state is defined as the time starting with a transaction with write or erase op-code sent to the device and ending when the device clears

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the status busy bit. P/E Suspended State starts when the device sets the program suspend status done bit after receiving a program suspend op-code. During P/E State and P/E Suspended State, OP1 is also allowed but not recommended

The table below shows all operation support in each state.

Operation	OP1 state	P/E state	P/E Suspended State
Suspend	Ignored	Yes-> P/E Suspended State(not chip erase or write status operation) No ->remain P/E state (chip erase or write status operation)	No
Resume	Ignored	No	Yes -> P/E state
All reads except Read status	Yes	No	Yes
All writes/erases	Yes	No	No
OP1	No	Yes but not recommended	Yes but not recommended
Write status	Yes	No	No
OP2	Yes->OP1 busy state (when extended status busy is 1) ->OP1 done state (when extended status busy is 0)	Yes. Will indicate the status associated with the OP1 operation.	Yes. Will indicate the status associated with the OP1 operation
Read status	Yes. Will indicate the busy state associated with the subsequent transaction issued to the SPI Flash.	Yes. Will indicate the busy state associated with the subsequent transaction issued to the SPI Flash.	Yes. Will indicate the busy state associated with the subsequent transaction issued to the SPI Flash.

Table 21. RPMC Operation



9 ELECTRICAL CHARACTERISTICS

9.1 Power-On Timing

Figure 43. Power-On Timing Sequence Diagram

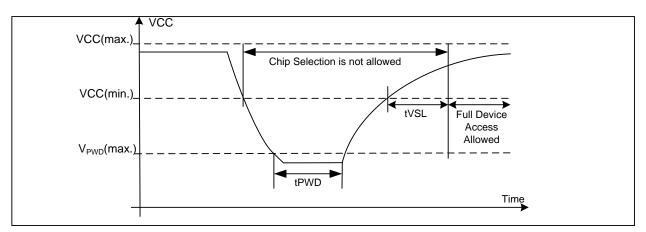


Table 22. Power-Up Timing and Write Inhibit Threshold

Symbol	Parameter	Min.	Max.	Unit
tVSL	VCC (min.) to device operation	2.5		ms
VWI	Write Inhibit Voltage	1	1.55	V
VPWD	VCC voltage needed to below VPWD for ensuring initialization will occur		0.5	V
tPWD	The minimum duration for ensuring initialization will occur	300		μs

9.2 Initial Delivery State

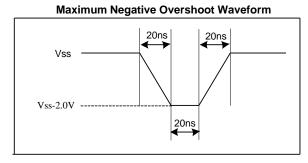
The device is delivered with the memory array erased: all bits are set to 1 (each Byte contains FFH). The Status Register contains 00H, except that DRV0 bit (S21) and QE bit (S9) are set to 1.

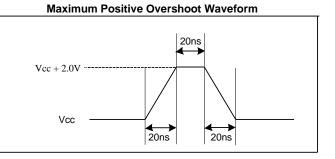
9.3 Absolute Maximum Ratings

Parameter	Value	Unit
Ambient Operating Temperature (T _A)	-40 to 85	°C
Storage Temperature	-65 to 150	°C
Transient Input/Output Voltage (note: overshoot)	-2.0 to VCC+2.0	V
Applied Input/Output Voltage	-0.6 to VCC+0.4	V
VCC	-0.6 to 4.2	V



Figure 44. Input Test Waveform and Measurement Level

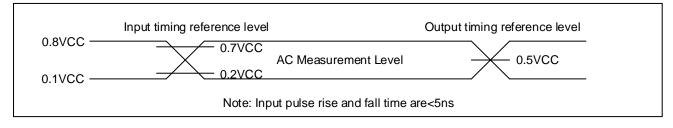




9.4 Capacitance Measurement Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit	Conditions
CIN	Input Capacitance			16	pF	VIN=0V
COUT	Output Capacitance			20	pF	VOUT=0V
CL	Load Capacitance	30			pF	
	Input Rise And Fall time			5	ns	
	Input Pulse Voltage	out Pulse Voltage 0.1VCC to 0.8VCC		8VCC	V	
	Input Timing Reference Voltage	0.2VCC to 0.7VCC		V		
	Output Timing Reference Voltage	0.5VCC			V	

Figure 45. Absolute Maximum Ratings Diagram





9.5 DC Characteristics

(T_A = -40°C ~85°C, VCC=1.65~3.6V)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit.
lι	Input Leakage Current				±6	μA
Ilo	Output Leakage Current				±6	μA
1	Standby Current	CS#=VCC,		36	110	
I _{CC1}	Standby Current	VIN=VCC or VSS		30	110	μA
		CS#=VCC,		2	40	A
Icc2	Deep Power-Down Current	VIN=VCC or VSS		3	40	μA
		CLK=0.1VCC / 0.9VCC				
		at 104MHz,		17	25	mA
		Q=Open(x4 I/O)				
		CLK=0.1VCC / 0.9VCC		12		
Іссз	Operating Current (Read)	at 90MHz,			20	mA
		Q=Open(x4 I/O)				
		CLK=0.1VCC / 0.9VCC				
		at 50MHz,		6	10	mA
		Q=Open(x4 I/O)				
I _{CC4}	Operating Current (PP)	CS#=VCC		15	25	mA
I _{CC5}	Operating Current (WRSR)	CS#=VCC		15	25	mA
I _{CC6}	Operating Current (SE)	CS#=VCC		15	25	mA
Icc7	Operating Current (BE)	CS#=VCC		15	25	mA
I _{CC8}	Operating Current (CE)	CS#=VCC		15	25	mA
VIL	Input Low Voltage				0.2VCC	V
VIH	Input High Voltage		0.8VCC			V
Vol	Output Low Voltage	I _{OL} = 100µA			0.2	V
Vон	Output High Voltage	І _{ОН} = -100µА	VCC-0.2			V

Note:

1. Typical value at T_{A} = 25 $^{\circ}\text{C}$, VCC = 3.3V.

2. Value guaranteed by design and/or characterization, not 100% tested in production.



9.6 AC Characteristics

(T_A = -40°C ~85°C, VCC=1.65~3.6V)

Symbol	Parameter	Min.	Тур.	Max.	Unit.
£	Serial Clock Frequency For: all commands except			404	N411-
fc1	Read (03H/13H), DC0=1 on 2.3-3.6V power supply			104	MHz
f.,	Serial Clock Frequency For: all commands except			00	MHz
f _{C2}	Read (03H/13H), DC0=1 on 1.65-2.3V power supply			90	
f	Serial Clock Frequency For: all commands except			90	
fсз	Read (03H/13H), DC0=0			80	MHz
f _R	Serial Clock Frequency For: Read (03H/13H)			50	MHz
t o	Sorial Clock High Time	45%			20
t _{CLH}	Serial Clock High Time	(1/fc _{Max})			ns
4	Sorial Clock Low Time	45%			
tcll	Serial Clock Low Time	(1/fc _{Max})			ns
tсьсн	Serial Clock Rise Time (Slew Rate)	0.2			V/ns
t CHCL	Serial Clock Fall Time (Slew Rate)	0.2			V/ns
t slch	CS# Active Setup Time	10			ns
t _{CHSH}	CS# Active Hold Time	10			ns
tsнсн	CS# Not Active Setup Time	10			ns
tchsl	CS# Not Active Hold Time	10			ns
t _{SHSL}	CS# High Time (Read/Write)	40			ns
t _{SHQZ}	Output Disable Time			12	ns
t _{CLQX}	Output Hold Time	1.2			ns
tovcн	Data In Setup Time	4			ns
tснох	Data In Hold Time	4			ns
	Clock Low To Output Valid (VCC=1.65~2.3V)			10.5	ns
t CLQV	Clock Low To Output Valid (VCC=2.3~3.6V)			7.5	ns
t _{DP}	CS# High To Deep Power-Down Mode			3	μs
	CS# High To Standby Mode Without Electronic				
t _{RES1}	Signature Read			40	μs
	CS# High To Standby Mode With Electronic Signature			10	
t _{RES2}	Read			40	μs
tsus	CS# High To Next Command After Suspend			40	μs
t _{RS}	Latency Between Resume And Next Suspend	100			μs
	CS# High To Next Command After Reset (Except			40	
t RST	From Erase)			40	μs
	CS# High To Next Command After Reset (From			05	
trst_e	Erase)			25	ms
tw	Write Status Register Cycle Time		5	20	ms
t _{BP1}	Byte Program Time (First Byte)		80	150	μs
t _{BP2}	Additional Byte Program Time (After First Byte)		5	15	μs
t _{PP}	Page Programming Time		0.5	4	ms

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t _{SE}	Sector Erase Time	70	500	ms
t _{BE1}	Block Erase Time (32K Bytes)	0.25	2	S
t _{BE2}	Block Erase Time (64K Bytes)	0.3	3	S
tce	Chip Erase Time (GD55WR512ME)	280	800	S
t _{WRKR}	Write Root Key Register	0.17	2	ms
t _{UHKR}	Update HMAC Key Register	100	150	μs
tімс	Increment Monotonic Counter	0.08	250	ms
t _{RMC}	Request Monotonic Counter	0.1	1	ms

Note:

1. Typical value at T_A = 25 $^\circ\!\mathrm{C}$, VCC = 3.3V.

2. Value guaranteed by design and/or characterization, not 100% tested in production.

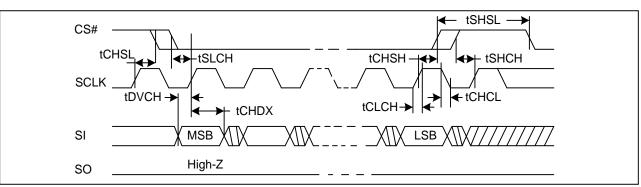


Figure 46. Input Timing

Figure 47. Output Timing

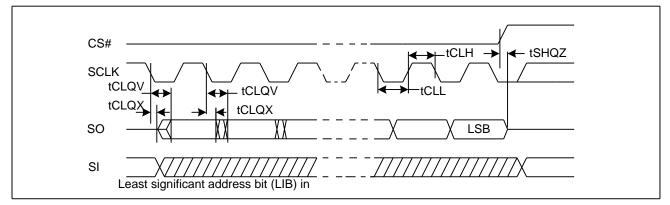


Figure 48. Resume to Suspend Timing Diagram

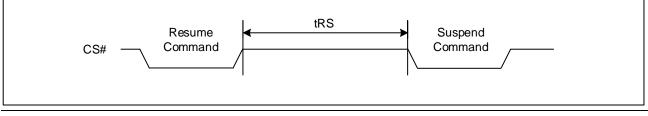




Figure 49 RESET# Timing

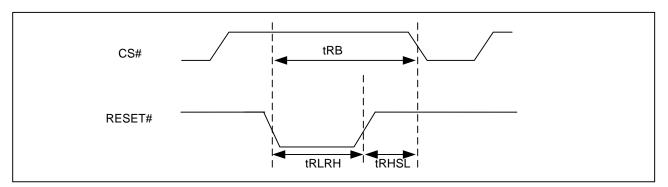


Table 23 Reset Timing

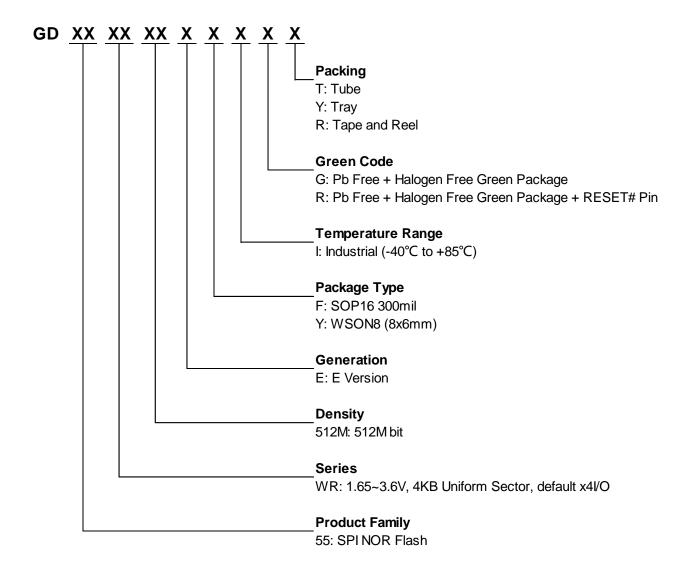
Symbol	Parameter	Min.	Тур.	Max.	Unit.
tRLRH	Reset Pulse Width	1			μs
tRHSL	Reset Hold time before next Operation	50			ns
tRB	Reset Recovery Time			12	ms

Note:

1. The device need tRB (max) at most to get ready for all commands after RESET# low.



10 ORDERING INFORMATION





10.1 Valid Part Numbers

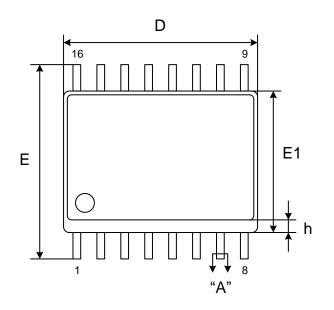
Please contact GigaDevice regional sales for the latest product selection and available form factors.

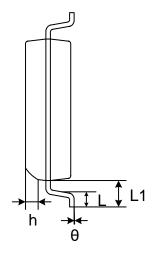
Temperature Range I: Industrial (-40°C to +85°C)

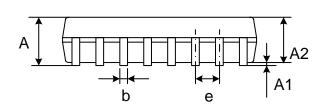
Product Number	Density	Package Type	Packing Options
GD55WR512MEFIR	512Mbit	SOP16 300mil	T/Y/R
GD55WR512MEYIG	512Mbit	WSON8 (8x6mm)	Y/R

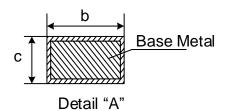
11 PACKAGE INFORMATION

11.1 Package SOP16 300MIL









Dimensions

Syı	Symbol		A1	A2	b	•	D	Е	E1	•		L1	h	θ		
U	Jnit	Α	AI	A2	מ	С	U	L		е	L	L 1	h	0		
	Min	-	0.10	2.05	0.31	0.10	10.20	10.10	7.40	1.27	1.27	0.40		0.25	0	
mm	Nom	-	0.20	-	0.41	0.25	10.30	10.30	7.50			1.27	-	1.40	-	-
	Max	2.65	0.30	2.55	0.51	0.33	10.40	10.50	7.60			1.27		0.75	8	

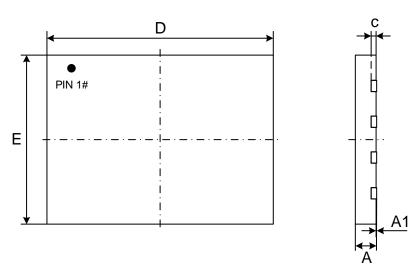
Note:

1. Both the package length and width do not include the mold flash.

2. Seating plane: Max. 0.1mm.

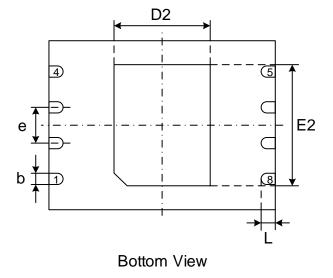


11.2 Package WSON8 (8x6mm)





Side View



Symbol Unit											
		Α	A1	С	b	D	D2	E	E2	е	
mm	Min	0.70	0.00	0.180	0.35	7.90	3.30	5.90	4.20		0.45
	Nom	0.75	0.02	0.203	0.40	8.00	3.40	6.00	4.30	1.27	0.50
	Max	0.80	0.05	0.250	0.45	8.10	3.50	6.10	4.40		0.55

Note:

1. Both the package length and width do not include the mold flash.

2. The exposed metal pad area on the bottom of the package is floating.

3. Coplanarity ≤ 0.08 mm. Package edge tolerance ≤ 0.10 mm.

4. The lead shape may be of little difference according to different package lead frames. These lead shapes are compatible with each other.



12 REVISION HISTORY

Version No	Description	Page	Date
1.0	Initial Release	All	2021-7-31
	Add Note for 104MHz Frequency of DC0=1	P14	
1.1	Modify COUT from 22pF to 20pF	P50	2021-12-2
	Update DC/AC parameter	P51-53	